

University of Mumbai
Examination 2020 under Cluster 06
(Lead College: Vidyavardhini's College of Engg Tech)
Examinations Commencing from 23rd December 2020 to 6th January 2021
Program: Electronics Engineering
Curriculum Scheme: Rev 2016
Examination: TE Semester VI
Course Code: ELX 604 and Course Name: Signals and System
Time: 2 hour **Max. Marks: 80**

R16_ETRX_VI_ELX604_QP1

Q1.	Choose the correct option for following questions. All the Questions are compulsory and carry equal marks
1.	Condition for energy signal is
Option A:	$0 < E < \infty$
Option B:	$E = 0$
Option C:	$E = \infty$
Option D:	$E = -\infty$
2.	Condition for continuous periodic signal is
Option A:	$X(t) = X(t+T)$
Option B:	$X(t) = X^*(t+T)$
Option C:	$X(t) = X(t-T)$
Option D:	$X(t) = X^*(t)$
3	What is the area of a Unit Impulse function?
Option A:	Zero
Option B:	Half of Unity
Option C:	Depends on the function
Option D:	Unity
4	A discrete signal is said to be even or symmetric if $x(-n)$ is equal to
Option A:	$x(n)$
Option B:	0
Option C:	$-x(n)$
Option D:	$-x(-n)$

5	A system is memoryless if
Option A:	Output at any time depends at present input and past input
Option B:	Output at any time depends at present input, past input and future input
Option C:	Output at any time depends only at present input
Option D:	Having memory
6	A system is said to be defined as non causal, when
Option A:	the output at the present depends on the input at an earlier time
Option B:	the output at the present does not depend on the factor of time at all
Option C:	the output at the present depends on the input at the current time
Option D:	the output at the present depends on the input at a time instant in the future
7	Convolution of the two discrete time sequences $x_1(n) = \{1, 1, 1, 1\}$ and $x_2 = \{4, 4, 4, 4\}$
Option A:	$\{1, 1, 1, 1\}$
Option B:	$\{4, 8, 12, 16, 12, 8, 4\}$
Option C:	$\{4, 3, 1, 1, 1, 2, -2\}$
Option D:	$\{1, 1, 1, -2, 2, 3, 4\}$
8	The system described by $y(n) = nx(n)$ is
Option A:	Linear, time variant and stable
Option B:	Non linear, time invariant and unstable
Option C:	Non linear, time variant and stable
Option D:	Linear, time variant and unstable
9	Laplace Transform of the signal $x(t) = u(t-1)$
Option A:	$1/s-1$
Option B:	e^{-s}/s
Option C:	$e^{-s}/(s-1)$
Option D:	$(s-1)$
10	Laplace transform of $A \cos wt u(t)$ is
Option A:	$As/(s^2-w^2)$

Option B:	$As/(s^2+w^2)$
Option C:	$A/(s^2+w^2)$
Option D:	$s/(s^2+w^2)$
11	The Laplace Transform of $t^n u(t)$ is
Option A:	$\frac{n!}{s^{n+1}}$
Option B:	$\frac{n!}{s^n}$
Option C:	$\frac{n}{s^{n+1}}$
Option D:	$\frac{n}{s^n}$
12	Time shifting property of Laplace transform is given as
Option A:	$L\{x(t-k)\} = e^{-sk} X(s)$
Option B:	$L\{x(t-k)\} = e^{-2sk} X(s)$
Option C:	$L\{x(t-k)\} = e^{-sk/2} X(s)$
Option D:	$L\{x(t-k)\} = e^{-sk/4} X(s)$
13	If $Z\{x_1(n)\} = X_1(z)$ and $Z\{x_2(n)\} = X_2(z)$ then
Option A:	$Z\{x_1(n) * x_2(n)\} = X_1(z) + X_2(z)$
Option B:	$Z\{x_1(n) * x_2(n)\} = X_1(z) - X_2(z)$
Option C:	$Z\{x_1(n) * x_2(n)\} = X_1(z) X_2(z)$
Option D:	$Z\{x_1(n) * x_2(n)\} = \frac{X_1(z)}{X_2(z)}$
14	What is the set of all values of z for which $X(z)$ attains a finite value?
Option A:	Region of convergence
Option B:	Radius of divergence
Option C:	Feasible solution
Option D:	Particular solution
15	Find Z-Transform of $a^n u(n)$
Option A:	$\frac{z}{z-a}$

Option B:	$\frac{z}{z+a}$
Option C:	$\frac{1}{z-a}$
Option D:	$\frac{1}{z+a}$
16	Fourier transform of signal $x(t) = e^{2t}u(-t)$ is given by
Option A:	$X(\omega) = \frac{1}{2-j\omega}$
Option B:	$X(\omega) = \frac{2}{1-j\omega}$
Option C:	$X(\omega) = \frac{1}{j2-\omega}$
Option D:	$X(\omega) = \frac{2}{j2-\omega}$
17	The Fourier Transform of signal $x(n) = a^n u(n)$ is given by
Option A:	$\frac{1}{1-ae^{j\omega}}$
Option B:	$\frac{1}{1+ae^{j\omega}}$
Option C:	$\frac{1}{1-ae^{-j\omega}}$
Option D:	$\frac{1}{a+e^{-j\omega}}$
Q18.	The Fourier transform of $x(t) = \cos \Omega_0 t u(t)$ is
Option A:	$\frac{\Omega_0}{\Omega^2 + \Omega_0^2}$
Option B:	$\frac{\Omega_0}{\Omega^2 - \Omega_0^2}$
Option C:	$\frac{-\Omega_0}{\Omega^2 + \Omega_0^2}$
Option D:	$\frac{-j\Omega}{\Omega^2 + \Omega_0^2}$
Q19.	Which property of periodic signal in DTFS gets completely clarified / identified by the equation $x(n - n_0)$?
Option A:	Conjugation
Option B:	Time Shifting

Option C:	Frequency Shifting
Option D:	Time Reversal
Q20.	Which are the Fourier coefficients in the following?
Option A:	a_0, a_n and b_n
Option B:	a_n
Option C:	b_n
Option D:	a_n and b_n

Q2	
A	Solve any Two 5 marks each
i.	Distinguish between power signals and energy signals. (5M) Determine the power and energy of the following continuous time signal $x(t) = 3\cos 5\Omega_0 t$
ii	Prove time Scaling property of Laplace transform (5M)
iii.	Check whether the system described by $y(t) = e^{t x(t)}$ is Memory less, Linearity, Time Variant, Causal, and stable (5M)
B	Solve any One 10 marks each
i	A D.T. system is represented as $y(n)=0.5 y(n-1)- 0.06 y(n-2) +x(n)$ with $y(-1)=y(-2)=1$ as initial condition . find the response of the system in closed form for an input $x(n)=(0.2)^n u(n)$
ii	$\frac{d^2 y(t)}{dt^2} + \frac{5dy(t)}{dt} + 6y(t) = \frac{7dx(t)}{dt} - 3x(t)$ Determine transfer function and obtain impulse response

Q3.	
A	Solve any Two 5 marks each
i)	Determine whether the signal is periodic or not? If a signal is periodic calculate it's fundamental period. $x(t) = 3\cos(5t + \frac{\pi}{6})$
ii)	Prove time shifting property of Z transform.
iii)	State the initial value theorem in Laplace transform and find initial and final value if $X(s)=\frac{s+10}{s^2+2s+2}$
B	Solve any One 10 marks each
i)	Determine the spectra of periodic signal $x(n)=\{1,1,1,0\}$ with period $N=4$

ii)	Compute the Fourier transform and sketch the magnitude and phase function of causal three sample sequence given by $x(n)=\frac{1}{3}$; $0 \leq n \leq 2$ Otherwise 0
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Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016

Examination: Third Year Semester VI

Course Code: ELXDLO6022 and Course Name: Electronic Product Design

Time: 1 hour

Max. Marks: 50

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Note to the students:- All the Questions are compulsory and carry equal marks .

Q1.	The ability of any electronic product to perform its intended function in the electromagnetic environment and not to be source of electromagnetic radiation to that environment is called
Option A:	Electromagnetic field
Option B:	Electromagnetic interference
Option C:	Electrostatic discharge
Option D:	Electromagnetic compatibility
Q2.	_____ is due to the formation of a current loop that generates a magnetic flux and couples energy between the circuits.
Option A:	Capacitive Coupling
Option B:	Electrostatic Coupling
Option C:	Electromagnetic Coupling
Option D:	Inductive Coupling
Q3.	_____ is the first phase of new product development.
Option A:	System specification
Option B:	Prototype
Option C:	Architectural design
Option D:	Requirements definition
Q4.	The process of exercising or evaluating a system or system component by manual or automated means to verify that it satisfied specified requirements or to identify differences between expected and actual results is
Option A:	Hardware testing
Option B:	Software testing
Option C:	System partitioning
Option D:	Architecture testing
Q5.	_____ language is dependent on processor architecture.
Option A:	High level
Option B:	Assembly

Option C:	Object Oriented Programming
Option D:	Computer Aided Software Engineering
Q6.	In which of the following model, the software development activity is divided into different phases and each phase consists of series of tasks and has different objectives.
Option A:	Waterfall model
Option B:	Spiral model
Option C:	Structured model
Option D:	Physical model
Q7.	_____ is a layer of copper or similar conductive internal to a PCB.
Option A:	Image Plane
Option B:	RF Plane
Option C:	Glass Plane
Option D:	Analog Plane
Q8.	The PCB in which conductors are on only one surface of a dielectric base.
Option A:	Single sided PCB
Option B:	Double sided PCB
Option C:	Multi-layer PCB
Option D:	6 layer PCB
Q9.	What is the first goal of testing process?
Option A:	Bug prevention
Option B:	Testing
Option C:	Execution
Option D:	Analysis
Q10.	An ideal op-amp requires infinite bandwidth because
Option A:	Signals can be amplified without attenuation
Option B:	Output common-mode noise voltage is zero
Option C:	Output voltage occurs simultaneously with input voltage changes
Option D:	Output can drive infinite number of devices
Q11.	_____ includes checking documents, design, codes and programs
Option A:	Checking
Option B:	Validation
Option C:	Verification
Option D:	Building
Q12.	Which of following is not visual techniques of documentation?
Option A:	Drawing
Option B:	Photographs
Option C:	Chart
Option D:	Memos

Q13.	_____ is a document that describes how to use a given product effectively and efficiently.
Option A:	Proposal
Option B:	Instructional Manual
Option C:	Service Manual
Option D:	Memo
Q14.	These are not the guidelines to deal with vibrations and shocks
Option A:	Use short component leads
Option B:	Avoid sliding joints
Option C:	Firmly fix transformer batteries
Option D:	Clamp small components
Q15.	Black box tests are _____ driven and white box tests are _____ driven.
Option A:	Data, logic
Option B:	logic, Data
Option C:	Data, Data
Option D:	Logic, logic
Q16.	Risk management is responsibility of the
Option A:	Investor
Option B:	Customer
Option C:	Project team
Option D:	Developer
Q17.	Critical frequencies have a wavelength greater than
Option A:	$\lambda/40$
Option B:	$\lambda/2$
Option C:	$\lambda/20$
Option D:	$\lambda/10$
Q18.	_____ routing topology provides for enhanced noise immunity against the propagation of radiated RF emissions.
Option A:	Stripline
Option B:	Ring
Option C:	Bus
Option D:	Microstrip
Q19.	The _____ depends on the number of turns, current and core material that can increase the relative permeability.
Option A:	Capacitance
Option B:	Resistance
Option C:	Relay
Option D:	Inductance

Q20.	Declaration of conformity is included in _____
Option A:	Service Manual
Option B:	Proposal
Option C:	Instructional Manual
Option D:	Memo
Q21.	Liability usually refers to a _____, while accountability refers to a _____
Option A:	Legal responsibility, social responsibility
Option B:	Social responsibility, legal responsibility
Option C:	Software, hardware
Option D:	Hardware, software
Q22.	_____ is important in PCB for optimal functionality and EMC suppression.
Option A:	Vertical Partitioning
Option B:	Horizontal Partitioning
Option C:	Functional Partitioning
Option D:	Symmetrical Partitioning
Q23.	Risk Exposure can be defined as:
Option A:	Probability* impact
Option B:	Probability / impact
Option C:	Impact/probability
Option D:	Probability + impact
Q24.	_____ is a heuristic that provides an estimate of how interdependent the modules are.
Option A:	Cohesion
Option B:	Coupling
Option C:	Functional design
Option D:	Architectural design
Q25.	The choice of the best suited hardware and software is done in the _____ phase of product development.
Option A:	System Specification
Option B:	Functional design
Option C:	Architectural design
Option D:	Prototype

Program: BE (Electronics) Engineering

Curriculum Scheme: **Revised - 2016**

Examination: **Third Year Semester VI**

Course Code: **ELXDLO6023** and Course Name: **Wireless Communication**

Time: **1-hour**

Max. Marks: **50**

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Note to the students:- All the Questions are compulsory and carry equal marks .

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Q1.	Handoff threshold is the level
Option A:	At the beginning of starting of Handoff process.
Option B:	In between the level of handoff process started and the minimum acceptable signal level.
Option C:	After the minimum acceptable signal level.
Option D:	At which call is terminated
Q2.	_____ cell shape is preferred to represent cells in a cellular system.
Option A:	Square
Option B:	Triangular
Option C:	Hexagonal
Option D:	Circular
Q3.	Cluster size is given by the equation $N = \underline{\hspace{2cm}}$.
Option A:	$i^2 + ij + j^2$
Option B:	$i^2 - ij + j^2$
Option C:	$i^2 + ij - j^2$
Option D:	$i + ij + j$
Q4.	In dynamic channel assignment policy following is not strategy related to it.
Option A:	Channels are allocated to cells permanently
Option B:	Allocate channels based on request by base station from MSC.
Option C:	Reduce the likelihood of blocking and increase capacity
Option D:	Increases the load on the MSC.
Q5.	Capacity of the system increases four-fold if the radius of cell is _____.
Option A:	Halved
Option B:	Doubled
Option C:	Tripled
Option D:	Quadrupled
Q6.	Signal to interference ratio in dB for a cellular communication system having $N=12$ and $i_0=6$ is
Option A:	15.56 dB

Option B:	14.56 dB
Option C:	13 dB
Option D:	12 dB
Q7.	In Mobile radio propagation environment, the typical value of path loss exponent γ is_____.
Option A:	2
Option B:	3
Option C:	4
Option D:	5
Q8.	Diffraction at high frequencies does not depends upon,
Option A:	Geometry of the subject
Option B:	Polarisation of the incident wave
Option C:	Amplitude of the incident wave
Option D:	Frequency of the incident wave
Q9.	_____ results from the presence of objects between the transmitter and the receiver
Option A:	Scattering
Option B:	Refraction
Option C:	Shadow Fading
Option D:	Doppler Effect
Q10.	Fresnel reflection coefficients is not a factor of
Option A:	Geometry of the object
Option B:	Polarization of the wave
Option C:	Properties of the material at which reflection occurs.
Option D:	Angle of incidence of wave
Q11.	Free space propagation path loss is _____.
Option A:	Inversely proportional to frequency of transmission
Option B:	Directly proportional to frequency of transmission
Option C:	Independent of frequency of transmission
Option D:	Directly proportional to square of the frequency of transmission
Q12.	Fading is not caused due to
Option A:	Obstacles
Option B:	Multipath propagation
Option C:	Frequency variation at the source
Option D:	Variation in amplitude and phase at receiver
Q13.	CDMA is a multiple access strategy for wireless communications based on _____.
Option A:	DSSS

Option B:	Fast FHSS
Option C:	Slow FHSS
Option D:	THSS
Q14.	_____ mobile equipment are the most complex.
Option A:	CDMA
Option B:	TDMA
Option C:	FDMA
Option D:	GSM
Q15.	In GSM, the Mobile Number of the subscriber is linked to the _____.
Option A:	ME
Option B:	SIM
Option C:	Both ME and SIM
Option D:	Neither ME and SIM
Q16.	The interface between BSC and MSC is referred to as _____.
Option A:	HLR
Option B:	Abis
Option C:	A
Option D:	U
Q17.	In GSM, Security triplets refer to _____.
Option A:	Kc, Ki and RAND
Option B:	RAND, SRES and Kc
Option C:	RAND and Kc
Option D:	Ki and RAND
Q18.	The differentiation between the carrier frequencies of the forward channels and reverse channels is an important design parameter related to _____.
Option A:	FDMA
Option B:	TDMA
Option C:	SDMA
Option D:	CDMA
Q19.	In which of the following the total available bandwidth is split into many channels of smaller bandwidth plus guard spaces between the channels?
Option A:	FHSS
Option B:	DSSS
Option C:	Both A and B
Option D:	Neither A nor B
Q20.	Which of these is not a function of the Service Middleware in the IP Core Network?

Option A:	Media Conversion
Option B:	Radio Resource Management
Option C:	Wireless Data transmission
Option D:	Mobility Management
Q21.	The Synchronisation Channel is assigned the Walsh Code _____.
Option A:	W0
Option B:	W32
Option C:	W1
Option D:	W43
Q22.	Which of the following leads to evolution of 3G networks in CDMA systems?
Option A:	IS-95
Option B:	IS-95B
Option C:	CDMA One
Option D:	CDMA2000
Q23.	What does SGSN stands for?
Option A:	Serial Gateway Supporting Node
Option B:	Supporting GGSN Support Node
Option C:	Supporting GPRS Support Node
Option D:	Supporting Gateway Support Node
Q24.	The mobile originated data packets are routed to the desired network by the _____.
Option A:	GGSN
Option B:	SGSN
Option C:	MSC
Option D:	BSC
Q25.	Power Control in CDMA2000 is carried out at _____.
Option A:	800 Hz on both links
Option B:	1500 Hz on both links
Option C:	800 Hz on Uplink and 1500 Hz on Downlink
Option D:	1500 Hz on Uplink and 800 Hz on Downlink

Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016

Examination: Third Year Semester VI

Course Code: ELXDLO6024 and Course Name: Computer Organization and Architecture

Time: 1 hour

Max. Marks: 50

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Note to the students:- All the Questions are compulsory and carry equal marks .

Q1.	Which one of the following is a multiplication algorithm
Option A:	Restoring method
Option B:	Non restoring method
Option C:	Quick sort algorithm
Option D:	Booth's algorithm
Q2.	The double precision representation of a floating point number in IEEE 754 format has a mantissa field of _____ bits
Option A:	32
Option B:	8
Option C:	52
Option D:	23
Q3.	In Booth's algorithm , the multiplicand is added to accumulator when the extreme right bits are
Option A:	00
Option B:	10
Option C:	01
Option D:	11
Q4.	Express the IEEE754 representation as decimal 0 10000001 010100000000000000000000
Option A:	5.25
Option B:	52.5
Option C:	525
Option D:	50.5
Q5.	A k bit address can address upto _____ locations of memory
Option A:	2^k
Option B:	$2*k$
Option C:	k
Option D:	$2/k$

Q6.	If the control signals are generated by combinational logic, then they are generated by a _____ controlled unit.
Option A:	Micro programmed
Option B:	vertical
Option C:	Interrupt
Option D:	Hardwired
Q7.	The microinstruction <i>MDRout,IRin</i> is implying which of the following actions?
Option A:	The data is placed in IR
Option B:	The opcode is placed in IR
Option C:	Data is placed on data bus and contents of R is read
Option D:	Data is placed on data bus and R is written into
Q8.	Which memory is on top of memory hierarchy for computer system from smallest to highest size
Option A:	Registers
Option B:	Cache
Option C:	Main Memory
Option D:	Magnetic Disk
Q9.	Which among the following memories is optical type of memory
Option A:	Semiconductor Memory
Option B:	Magnetic disk
Option C:	Magnetic Tape
Option D:	Compact disk
Q10.	How many Transistors required in implementation of 1- bit DRAM?
Option A:	0
Option B:	1
Option C:	4
Option D:	6
Q11.	Number of address line required for accessing 4096 bytes of memory
Option A:	10
Option B:	12
Option C:	14
Option D:	16

Q12.	With a Main memory Size of 16KB and Cache Size of 512 bytes. Size of TAG in bits required in Direct mapping
Option A:	4 bits
Option B:	5 bits
Option C:	6 bits
Option D:	8 bits
Q13.	Which locality of reference takes advantage of program loops
Option A:	Temporal Locality
Option B:	Spatial Locality
Option C:	Sequential Locality
Option D:	Dynamic Locality
Q14.	A set-associative cache consists of 64 lines, or slots, divided into four-line sets. Main memory contains 4K blocks of 128 words each. Show the format of main memory addresses.
Option A:	tag=8, set=4, word=7
Option B:	tag=4, set=8, word=7
Option C:	tag=4 set=4, word=4
Option D:	tag=8, set=8, word=8
Q15.	One of the reasons the PCI bus is called a green machine as
Option A:	It has incident wave switching
Option B:	it has CMOS drivers
Option C:	it floats the address and data bus
Option D:	It does not employ bus parking
Q16.	The technique whereby the DMA controller steals the access cycles of the processor to operate is called _____
Option A:	Fast conning
Option B:	Memory Con
Option C:	Cycle stealing
Option D:	Memory stealing

Q17.	_____ provides a separate physical connection to the memory.
Option A:	PCI BUS
Option B:	PCI interface
Option C:	PCI bridge
Option D:	Switch circuit
Q18.	What is the correct definition of the term 'SIMD'?
Option A:	Single Input, Multiple Destinations
Option B:	Single Integration, Multiple Dynamics
Option C:	Single Instruction, Multiple Data
Option D:	Single Interrupt, Multiple Distribution
Q19.	Which one of the following is a technique to avoid data hazards?
Option A:	Operand forwarding
Option B:	Internal data forwarding
Option C:	Store-Load forwarding
Option D:	Load-Load forwarding
Q20.	In which group of the following computers, there are more than one processor units having the ability to execute several instructions in different data simultaneously ?
Option A:	SISD
Option B:	MIMD
Option C:	SIMD
Option D:	MISD
Q21.	Which of the following processors features superscalar architecture?
Option A:	IBM 370
Option B:	Intel 80486
Option C:	SPARC
Option D:	Pentium
Q22.	Which of the following techniques are used to solve Write After Read and Write After Write dependencies in superscalar architecture?
Option A:	Reorder buffer
Option B:	Multiple Pipelines

Option C:	Loop Buffers
Option D:	Register renaming
Q23.	Uniform Memory Access is applicable for
Option A:	Real time applications
Option B:	real-time applications and time-critical applications.
Option C:	general purpose applications and time-sharing applications
Option D:	Time critical applications
Q24.	Non Uniform Memory Access is ----- to uniform Memory Access.
Option A:	Faster
Option B:	slower
Option C:	Equal
Option D:	Comparable
Q25.	Which among the following is type Memory Interleaving
Option A:	Memory Hierarchy
Option B:	Memory Banking
Option C:	Memory Segmentation
Option D:	Virtual Memory

University of Mumbai
Examination 2020 under cluster Vidyavardhini's College of Engg & Tech
Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016 (CBCGS)

Examination: Third Year Semester VI

Course Code: ELX601 Course Name: Embedded System and RTOS

Time: 1 hour

Max. Marks: 50

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Note:

1. All Questions are compulsory and carry equal marks.
2. Assume suitable data wherever necessary.

Q1.	Which is not an essential tight constraint/s related to the design metrics of an embedded system?
Option A:	Low power consumption
Option B:	Fast data processing for real-time operations
Option C:	Lesser memory requirement
Option D:	Able to support generic hardware
Q2.	Which of the following is related with I2C protocol?
Option A:	MOSI
Option B:	MISO
Option C:	SDA
Option D:	SCLK
Q3.	In embedded system as volume of production increases
Option A:	The per-product cost decreases
Option B:	The per-product cost increases
Option C:	NRE cost increases

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Option D:	Time to market increases
Q4.	In an embedded system reducing clock frequency results to
Option A:	Increase in power consumption
Option B:	decrease in power consumption
Option C:	Increase in performance
Option D:	Decrease in execution time
Q5.	RM Schedulable upper bound for a system with 4 tasks is
Option A:	0.66
Option B:	0.95
Option C:	0.76
Option D:	0.44
Q6.	In the FSM diagram, what does the information below the line in the circle represent?
Option A:	Change of state
Option B:	Output value
Option C:	State
Option D:	Initial state
Q7.	Which of the following is an example of 2 wire Communication Interface?
Option A:	SCI
Option B:	Wi-Fi
Option C:	Ethernet
Option D:	EEE1394

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Q8.	In a CAN bus messages are
Option A:	Transmitted from one node to another based on addresses
Option B:	Not received by all nodes
Option C:	Embedded in the CAN message itself.
Option D:	Not message-based protocol
Q9.	A secure ATM card application uses
Option A:	CAN
Option B:	I2C
Option C:	SCI
Option D:	SPI
Q10.	Which of the following is not a characteristics of SPI bus
Option A:	Uses only 4 wires
Option B:	No start and stop bits
Option C:	Only single master is enabled at a time
Option D:	No extra error checking bits
Q11.	Specify the type of motor is used for alignment and throttle control in ACC.
Option A:	DC motor
Option B:	AC motor
Option C:	Stepper motor
Option D:	Servo Motor
Q12.	Interrupt priority is needed to
Option A:	Interrupt the processor unnecessarily
Option B:	To resolve priority conflicts due to concurrent arriving interrupts
Option C:	To disable nesting of interrupts

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Option D:	To reduce interrupt latency
Q13.	One of the major drawbacks of assembly language programming over C is
Option A:	Codes are not portable
Option B:	Program executes faster
Option C:	Lower memory requirements
Option D:	hardware specific instructions are available
Q14.	Which of the following is a data structure in C
Option A:	data types
Option B:	Stacks
Option C:	Pointers
Option D:	modifiers
Q15.	Real Time kernel main components are
Option A:	Timing logic, control logic, sequencing
Option B:	Scheduler, RTOS objects, Services
Option C:	Clock system, JTAG interface, SFRs
Option D:	White box, Scheduler, timing logic
Q16.	Function of TCB (Task control block) is
Option A:	keeps task priority during program execution
Option B:	decides the dead-time of the task
Option C:	keeps task specific information during context switch
Option D:	keeps the information about semaphore
Q17.	Which of the following is a method of IPC
Option A:	semaphore
Option B:	pipe

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Option C:	TCB
Option D:	Spin lock
Q18.	Software testing method which is used to test software without knowing internal structure of code or program
Option A:	Black Box Testing
Option B:	White Box Testing
Option C:	Boundary Scan
Option D:	Unit Testing
Q19.	μ COS-II is based on which of the following kernel model.
Option A:	A microkernel
Option B:	A megakernel
Option C:	An Exokernel
Option D:	A hybrid kernel
Q20.	In an OS the number of tasks executed per unit of time is called as
Option A:	turn around time
Option B:	Response time
Option C:	CPU utilization
Option D:	Throughput
Q21.	Which is the MicroC function responsible for starting the different OS kernel data structure?
Option A:	OSInit()
Option B:	OSIdle()
Option C:	OSStart()
Option D:	OSTaskCreate()
Q22.	In circuit emulator is a hardware device which emulates

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Option A:	memory
Option B:	target CPU
Option C:	I/O device
Option D:	software
Q23.	Choose the appropriate Characteristic of a Logic Analyzer.
Option A:	It measures Signal Amplitudes
Option B:	Detects Transients and Unwanted Pulses
Option C:	Characterize waveform and jitter
Option D:	Detects Timing Violations
Q24.	Which of the following port is not available in the ACVM?
Option A:	Port_Refund
Option B:	Port_Collect
Option C:	Port_Deliver
Option D:	Port_Decode
Q25.	Which of the following is not in the list of Requirements Table for an Automatic Chocolate Vending Machine (ACVM)?
Option A:	Logic
Option B:	Inputs
Option C:	Outputs
Option D:	Purpose

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Examination 2020 under Cluster 06
(Lead College: Vidyavardhini's College of Engg Tech)

Examinations Commencing from 23rd December 2020 to 6th January 2021

Program: **Electronics Engineering**

Curriculum Scheme: Rev 2016

Examination: TE Semester VI

Course Code: ELXDLO6023 and Course Name: Wireless Communication

Time: 2 hour

Max. Marks: 80

Q1.	Choose the correct option for following questions. All the Questions are compulsory and carry equal marks
1.	A regular _____ shaped cell is the closest approximation to a circle out which has been used for cellular system design.
Option A:	Circular
Option B:	Triangular
Option C:	Square
Option D:	Hexagonal
2.	The ability of base station to pick up the correct signal as mobile enters from cell one to cell two is_____.
Option A:	Cell splitting
Option B:	Soft hand off
Option C:	Coverage
Option D:	Cell sectoring
3.	In mobile radio channels, the _____ is commonly used to describe the statistical time varying nature of the received fading signal.
Option A:	Rayleigh distribution
Option B:	Binomial Distribution
Option C:	Ricean distribution
Option D:	Poisson Distribution
4.	Path loss in free space model is defined as difference of _____.
Option A:	Effective transmitted power and gain
Option B:	Effective received power and distance between transmitter and receiver
Option C:	Gain and received power
Option D:	Effective transmitter power and receiver power
5.	Small scale fading describes the _____ fluctuations of the amplitude, phases of a signal.
Option A:	Slow
Option B:	Instantaneous
Option C:	Rapid
Option D:	Different

6.	Doppler frequency or Doppler shift is given by_____. (where λ_c is the wavelength of the carrier signal, V_m is the relative velocity of the mobile, the angle θ is between the motion of the mobile and direction of arrival of the scattered waves.)
Option A:	$\lambda_c V_m \cos \theta$
Option B:	$(1/\lambda_c) V_m \cos \theta$
Option C:	$[1/(\lambda_c V_m)] \cos \theta$
Option D:	$(1/ V_m) \lambda_c \cos \theta$
7.	The period of a PN sequence produced by a linear m stage shift register cannot exceed _____ symbols.
Option A:	2m
Option B:	M
Option C:	2^m-1
Option D:	2^m
8.	Which of the following is not a property of spread spectrum techniques?
Option A:	Difficult to jam the signals
Option B:	Cross-talk elimination
Option C:	Multipath fading
Option D:	Co-existence with other systems
9.	The differentiation between the carrier frequencies of the forward channels and reverse channels is an important design parameter related to _____ technique.
Option A:	TDMA
Option B:	FDMA
Option C:	CDMA
Option D:	SDMA
10.	The guard time between the time slots in a TDMA frame helps in minimizing the interference due to _____along different radio paths in the wireless channel.
Option A:	Propagation Delays
Option B:	Adjacent Channel
Option C:	Multipath Fading
Option D:	Timing inaccuracies
11.	Which of the following multiple access techniques are used by second generation cellular systems?
Option A:	FDMA/FDD and TDMA/FDD
Option B:	TDMA/FDD and CDMA/FDD
Option C:	FDMA/FDD and CDMA/FDD
Option D:	FDMA/FDD only
12.	The _____ is the database at MSC that keeps the information about the identity of mobile phone equipment.
Option A:	HLR
Option B:	VLR

Option C:	AuC
Option D:	EIR
13.	The gross data rate of each carrier channel in GSM is_____.
Option A:	270.833 kbps
Option B:	33.854 kbps
Option C:	24.7 kbps
Option D:	13.4 kbps
14.	The 2G GSM technology uses a carrier separation of_____.
Option A:	30KHz
Option B:	200KHz
Option C:	1.25MHz
Option D:	300Hz
15.	Which of the following services is not defined by the GSM?
Option A:	Bearer
Option B:	Supplementary
Option C:	Complimentary
Option D:	Tele
16.	The CDMA reverse channel employs _____ digital modulation technique.
Option A:	BPSK
Option B:	OQPSK
Option C:	QPSK
Option D:	OFDM
17.	Each IS-95 channel occupies _____ of spectrum on each one way link.
Option A:	1.25 MHz
Option B:	1.25 kHz
Option C:	200 kHz
Option D:	125 kHz
18.	The ____ channel is used for sending short messages including broadcast messages.
Option A:	Forward Traffic
Option B:	Paging
Option C:	Sync
Option D:	Pilot
19.	Which is not an advantage of 4G LTE network over 3G network?
Option A:	Low power consumption
Option B:	More Spectral Efficiency
Option C:	Flexibility with other networks
Option D:	Non Scalability

20.	What is the chip rate of W-CDMA?
Option A:	1.2288 Mcps
Option B:	270.833 Ksps
Option C:	3.84 Mcps
Option D:	100 Mcps

Option 1

Q2	Solve any Four out of Six 5 marks each
A	Explain the concept of frequency reuse. Derive the expression for relationship between the size of the cluster “N” and the frequency reuse distance “D”.
B	Classify the small scale fading in wireless channel based on multipath time delay spread and explain its features.
C	Explain Frequency Hopping Spread Spectrum (FHSS) with block diagram.
D	Describe the services and features of GSM.
E	Enlist and Explain the three identifiers used in GSM.
F	Explain RAKE receiver used in CDMA system with neat diagram.
Q3.	Solve any Four out of Six 5 marks each
A	What is meant by Co-channel interference? Derive the expression for S/I Ratio (Signal to Co-channel interference).
B	Explain free space propagation model.
C	Differentiate between TDMA, FDMA and CDMA.
D	Draw architecture of GSM along with the interfaces used in it and explain all the entities of GSM.
E	Explain the working of forward channels of CDMA IS-95 modulation process.
F	Write a short note on W-CDMA.

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Examination 2020 under Cluster 06
(Lead College: Vidyavardhini's College of Engg Tech)
Examinations Commencing from 23rd December 2020 to 6th January 2021

Program: **Electronics Engineering**

Curriculum Scheme: Rev 2016

Examination: TE Semester VI

Course Code: ELXDLO6024 and Course Name: Computer Organization and Architecture

Time: 2 hour

Max. Marks: 80

Q1.	Choose the correct option for following questions. All the Questions are compulsory and carry equal marks
1.	The double precision representation of a floating-point number in IEEE 754 format has a mantissa field of _____bits
Option A:	32
Option B:	8
Option C:	52
Option D:	23
2.	In a _____ control unit, the control signals are generated by combinational logic.
Option A:	Microprogrammed
Option B:	vertical
Option C:	Logical
Option D:	Hardwired
3.	The microinstruction MDRout, IRin is implying which of the following actions?
Option A:	The data is placed in IR
Option B:	The opcode is placed in IR
Option C:	Data is placed on data bus and contents of R is read
Option D:	Data is placed on data bus and R is written into
4.	How many Transistors required in implementation of 1- bit DRAM?
Option A:	0
Option B:	1
Option C:	4
Option D:	6
5.	If direct mapped cache memory has 128 blocks of 16 words each and main memory has 64K words arranged as 4K block of 16 words each, then the main memory address is arranged as
Option A:	tag=5, set=7, word=4
Option B:	tag=16, set=4, word=7
Option C:	tag=4 set=16, word=4
Option D:	tag=12, set=7, word=4
6.	Which locality of reference takes advantage of program loops
Option A:	Temporal Locality
Option B:	Spatial Locality
Option C:	Sequential Locality
Option D:	Dynamic Locality

7.	One of the reasons the PCI bus is called a green machine as
Option A:	It has incident wave switching
Option B:	it has CMOS drivers
Option C:	it floats the address and data bus
Option D:	It does not employ bus parking
8.	Which of the following techniques are used to solve Write After Read and Write After Write dependencies in superscalar architecture?
Option A:	Reorder buffer
Option B:	Multiple Pipelines
Option C:	Loop Buffers
Option D:	Register renaming
9.	If 16k X 8 memory chips are used to construct 32k x16 memory, how many chips will be required?
Option A:	8 Chips
Option B:	12 Chips
Option C:	4 Chips
Option D:	2 Chips
10.	A microprogram sequencer
Option A:	Generates the address of next micro instruction to be executed
Option B:	Generates the control signals to execute a microinstruction.
Option C:	Sequentially averages all microinstructions in the control memory.
Option D:	Enables the efficient handling of a micro program subroutine.
11.	The hardware mechanism that allows a device to notify the CPU is called _____
Option A:	Polling
Option B:	Interrupt
Option C:	Driver
Option D:	Controller
12.	The technique whereby the DMA controller steals the access cycles of the processor to operate is called _____
Option A:	Memory stealing
Option B:	Bus stealing
Option C:	Cycle stealing
Option D:	I/O stealing
13.	When two instructions contend for the same functional unit, following occurs?
Option A:	Data hazard
Option B:	Branch hazard
Option C:	Resource hazard
Option D:	RAW hazard

14.	Which of the following processor organizations is suitable for vector operations?
Option A:	SISD
Option B:	MIMD
Option C:	SIMD
Option D:	MISD
15.	Consider following two pseudo instructions: $Y = A + B$ $X = Z + Y$ While executing above instructions in a pipelined processor, a delay was introduced due to unavailability of result from first instruction. This is known as _____ hazard
Option A:	Data
Option B:	Control
Option C:	Resource
Option D:	Structural
16	_____ address space gives the PCI its plug and play capability.
Option A:	Configuration.
Option B:	I/O
Option C:	Stack
Option D:	Memory
17.	A 512K x 8 memory chip has _____ data lines
Option A:	8
Option B:	9
Option C:	19
Option D:	18
18.	SPEC stands for _____
Option A:	Standard Performance Evaluation Code
Option B:	System Processing Enhancing Code
Option C:	System Performance Evaluation Corporation
Option D:	Standard Processing Enhancement Corporation
19.	Which of the following options indicate steps required for an instruction fetch cycle ?
Option A:	MAR ← PC, MDR ← [MAR], PC ← PC+1, MDR ← IR
Option B:	MAR ← PC, MDR ← [MAR], PC ← PC+1, IR ← MDR
Option C:	MAR ← PC, [MAR] ← MDR, PC ← PC+1

	IR ← MDR
Option D:	PC ← MAR, [MAR] ← MDR, PC ← PC+1, IR ← MDR
20.	Which of the following is false regarding VLIW architecture
Option A:	Requires complex compiler
Option B:	No structural hazard checking
Option C:	Has out of order execution
Option D:	Reduces hardware complexity

Q2	
A	Solve any Two 5 marks each
i.	Write short notes on any two hazards in Pipelining
ii.	Write short notes on memory mapped and I/O mapped I/O
iii.	Write short notes on GPU
B	Solve any One 10 mark each
i.	Explain various methods to achieve cache coherency.
ii.	Explain the DMA modes of transfer. State its advantages over the other I/O transfer methods.
Q3.	
A	Solve any Two 5 marks each
i.	Explain single precision format for floating point number representation.
ii.	Write short notes on nano programming
iii.	Write short notes on superscalar architecture.
B	Solve any One 10 marks each
i.	Explain execution of a complete instruction with details. Use single bus organisation.
ii.	Explain how a virtual address is converted into a physical address using paging. Also explain Translation Look-aside Buffer

University of Mumbai
Examination 2020 under Cluster 06
(Lead College: Vidyavardhini's College of Engg Tech)
Examinations Commencing from 23rd December 2020 to 6th January 2021
Program: Electronics Engineering
Curriculum Scheme: Rev 2016
Examination: TE Semester: VI
Course Code: ELXDLO6021 and Course Name: Microwave Engineering
Time: 2 hour Max. Marks: 80

Q1.	Choose the correct option for following questions. All the Questions are compulsory and carry equal marks
1.	During TM mode of propagation through rectangular waveguide which field component is zero?
Option A:	Hx
Option B:	Ez
Option C:	H _z
Option D:	E _y
2.	For radius r=5 cm air filled circular waveguide with parameter X ₁₁ '= 1.841 what will be the cut-off frequency for dominant TE ₁₁ mode?
Option A:	1.758 GHz
Option B:	0.967 GHz
Option C:	2.675 GHz
Option D:	3.954 GHz
3.	Guide wavelength for waveguide in laboratory is measured using -----.
Option A:	Magic tee
Option B:	Directional coupler
Option C:	Slotted waveguide with probe
Option D:	Isolator
4.	Which one of the following devices can be used for broadband amplification of microwave energy?
Option A:	Reflex klystron
Option B:	Two cavity klystron
Option C:	Travelling-wave tube
Option D:	Magnetron
5.	The transmission line using two ground planes is -----.
Option A:	Microstrip
Option B:	Strip line
Option C:	Parallel wire line
Option D:	Coaxial line
6.	A hollow rectangular waveguide cannot propagate TEM waves because of -----.
Option A:	High losses
Option B:	Type of conducting material used

Option C:	Waveguide is one conductor system
Option D:	Low frequency
7.	In a two-cavity klystron, velocity modulation of the electron beam is produced by -----.
Option A:	Collector
Option B:	Buncher cavity
Option C:	Catcher cavity
Option D:	Cathode
8.	The purpose of the magnet, which surrounds a travelling-wave tube, is to -----.
Option A:	Accelerate the electron beam
Option B:	Modulate the velocity of the electron beam
Option C:	Slow down the electromagnetic wave on the helix
Option D:	Hold the electron beam from spreading out
9.	Which one of the following is a Transferred Electron Device (TED)?
Option A:	TRAPATT diode
Option B:	Crystal diode
Option C:	Gunn diode
Option D:	PIN Diode
10.	Microwave component immediately connected after reflex klystron in microwave bench set is -----.
Option A:	Slotted waveguide
Option B:	Frequency meter
Option C:	Attenuator
Option D:	Isolator
11.	H-plane Tee is also known as -----.
Option A:	Shunt Tee
Option B:	Series Tee
Option C:	Magic Tee
Option D:	Hybrid Tee
12.	Identify correct statement in relation with two cavity klystron amplifier and travelling wave tube amplifier (TWT).
Option A:	In two cavity klystron amplifier RF field is moving & electron beam is stationary whereas in TWT both are stationary
Option B:	In two cavity klystron amplifier RF field is moving & electron beam is stationary whereas in TWT both are moving
Option C:	In two cavity klystron amplifier RF field is stationary & electron beam is moving whereas in TWT both are moving
Option D:	In two cavity klystron amplifier RF field is stationary & electron beam is moving whereas in TWT RF field is moving & electron beam is stationary
13.	Which is not a mode of Gunn Diode?
Option A:	Limited Space Charge
Option B:	Drift Space Mode
Option C:	Transit Time Domain
Option D:	Quenched Domain

14.	Value of bunching parameter X is..... for two cavity klystron.
Option A:	2.408
Option B:	1.732
Option C:	1.414
Option D:	1.841
15.	Scattering parameter S_{12} signifies power flow from.....
Option A:	Port 2 to port 1
Option B:	Port 1 to port 2
Option C:	Port 1 to port 1
Option D:	Port 2 to port 2
16.	Gyrator is a device that produces a phase shift ofbetween the input and output.
Option A:	90°
Option B:	180°
Option C:	45°
Option D:	270°
17. microwave diode can be used as a switch.
Option A:	PIN Diode
Option B:	TRAPATT
Option C:	GUNN
Option D:	IMPATT
18.	Zero property of S matrix involves multiplication of element of any row or column to it's element of row or column.
Option A:	adjacent
Option B:	same
Option C:	Zero
Option D:	infinity
19.	When the propagation constant has negative sign in imaginary part it signifies wave in TWTA.
Option A:	Forward
Option B:	Constant
Option C:	Infinite
Option D:	Backward
20.	For four port directional coupler, identify correct relation, where I=Isolation, C= Coupling, D= Directivity. Note that I, C, D are in dB.
Option A:	$D=I+C$
Option B:	$I=C+D$
Option C:	$C=D+I$
Option D:	$I=C*D$

Q2 (20 Marks)	Solve any four questions out of six of the following. Each question carries five marks.
A	Explain in brief advantages & applications of microwaves.
B	Explain in brief operation of magic i.e. E-H plane tee
C	Explain in brief role of slow wave structure in TWT.
D	Draw & explain structure of IMPATT diode. State disadvantages of it.
E	Differentiate between O-type & M-type microwave tubes.
F	For 3.5 GHz microwave signal propagating through air filled rectangular waveguide of dimension 7.0cm x 3.5 cm, calculate cut-off frequency (f_c), guide wavelength (λ_g) and phase velocity for TE_{10} mode.

Q3 (20 Marks)	Solve any two questions out of three of the following. Each question carries ten marks.
A	Draw schematic of four port directional coupler and derive scattering matrix for it.
B	Derive an expression for Hull cut-off voltage and magnetic field density equation in cylindrical magnetron.
C	Draw microwave bench set up for measurement of unknown load impedance in laboratory and explain in details steps involved in it.

University of Mumbai
Examination 2020 under Cluster 06
(Lead College: Vidyavardhini's College of Engg Tech)
 Examinations Commencing from 23rd December 2020 to 6th January 2021
 Program: Electronics Engineering
 Curriculum Scheme: Rev 2016
 Examination: TE Semester VI
 Course Code: ELXDLO6022 and Course Name: Electronic Product Design

Time: 2-hour

Max. Marks: 80

Q1.	Choose the correct option for following questions. All the Questions are compulsory and carry equal marks
1.	The purpose of shielding is to control _____ from one region to the other.
Option A:	the propagation of electric field and magnetic field
Option B:	the propagation of magnetic field only
Option C:	the propagation of electric field only
Option D:	the propagation of either electric field or magnetic field
2.	The _____ model describes the physical architecture of the system based on real components such as microprocessors, arrayed logics, special purpose processors, analog and digital components, and the many interconnections between them.
Option A:	Functional
Option B:	Prototype
Option C:	Waterfall
Option D:	Architectural
3.	Accountability usually refers to a _____, while liability refers to a _____.
Option A:	Hardware, software
Option B:	social responsibility, legal responsibility
Option C:	Software, hardware
Option D:	legal responsibility, social responsibility
4.	IEEE Standard for Software Test Documentation defines _____ as “a document describing the scope, approach, resources and schedule of intended testing activities”
Option A:	White box testing
Option B:	Test Planning
Option C:	Black box testing
Option D:	Grey box testing
5.	Electromagnetic coupling of noise occurs at
Option A:	DC to 10 MHZ
Option B:	> 3 KHz

Option C:	>1 KHz
Option D:	>15 MHz
6.	White box tests are _____ driven and black box tests are _____ driven.
Option A:	logic, data
Option B:	data, logic
Option C:	data, data
Option D:	logic, logic
7.	The source listings, schematics, and engineering notebooks are which type of document?
Option A:	Reviews and reports
Option B:	Design documents
Option C:	Instructions
Option D:	Plans
8.	Which of the following elements comprise of all of the passive devices?
Option A:	Resistors, Capacitors and SCRs
Option B:	Transformers, TRIACs and DIACs
Option C:	Transformers, Inductors and Diodes
Option D:	Vacuum Tubes, SCRs and Diodes
9.	What is not true with respect to Verification:
Option A:	It is the process to ensure whether the product that is developed is right or not.
Option B:	It is Static testing
Option C:	It is the process of checking that a software achieves its goal without any bugs
Option D:	It is Dynamic testing
10.	The distance spacing between ground stitch locations in PCB should not exceed ___ of the highest frequency, or harmonic of concern.
Option A:	$\lambda/3$
Option B:	$\lambda/5$
Option C:	$\lambda/20$
Option D:	$\lambda/2$
11.	Risk Exposure can be defined as:
Option A:	Probability + impact
Option B:	Probability / impact
Option C:	Probability \times impact
Option D:	Impact/probability
12.	_____ deal with the mental processes and capabilities of human being to process information and interact with data.
Option A:	Physical Ergonomics
Option B:	Organizational Ergonomics
Option C:	Cognitive Ergonomics
Option D:	Test cases

13.	Which statement is not correct with respect to image plane?
Option A:	Image planes provide a high-impedance path for RF currents to return to their source.
Option B:	This layer may be identified as a voltage plane, ground plane, or 0 V reference plane physically adjacent to a circuit or signal routing layer.
Option C:	An image plane is a layer of copper or similar conductive internal to a PCB.
Option D:	An image plane reduces ground noise voltage.
14.	_____ is the capability of electrical and electronic systems, equipment, and devices to operate in their intended electromagnetic environment within a defined margin of safety, and at design levels or performance, without suffering or causing unacceptable degradation as a result of electromagnetic interference.
Option A:	Immunity
Option B:	Electromagnetic compatibility (EMC)
Option C:	Radio Frequency (RF)
Option D:	Containment
15.	Which statement is not the reason, of why the Spiral model is an improvement on the Waterfall and V models?
Option A:	it provides for multiple builds as well as several opportunities for risk assessment and for customer involvement.
Option B:	it is elaborate
Option C:	difficult to manage
Option D:	always keep all developers occupied during all of the phases
16.	Test cases are created in which phase?
Option A:	Test Planning
Option B:	Test Specification
Option C:	Test Requirement
Option D:	Test Configuration
17.	The presence of error at the time of execution of the software is
Option A:	Fault
Option B:	Error
Option C:	Failure
Option D:	Bug
18.	_____ is a relative measure of a device, or a system's propensity to be disrupted or damaged by EMI exposure to an incident field or signal. It is the lack of immunity.
Option A:	Containment
Option B:	Suppression
Option C:	Immunity
Option D:	Susceptibility
19.	The _____ is similar to the Waterfall model except that it places greater emphasizes on the importance of addressing testing activities up front instead of later in the life cycle.
Option A:	V Cycle
Option B:	Spiral

Option C:	Image plane
Option D:	Microstrip
20.	The drawback of using ----- is that the outer layers of the PCB can occasionally radiate RF energy to the environment, without the protection of a plane on both sides.
Option A:	Grounding
Option B:	Stripline
Option C:	Microstrip
Option D:	Image planes

Q2	Solve any Two Questions out of Three 10 marks each
A	Explain how mapping of functions to hardware is done in architectural design.
B	Define documentation and explain different types of documentation with their specific use and format.
C	Explain different routing topologies used in PCB designing.

Q3.	Solve any Two Questions out of Three 10 marks each
A	Explain the need of ESD protection in PCB designing and the techniques used in ESD protection.
B	What is the role of characterization in case of debugging and troubleshooting?
C	Draw a sketch of front panel of Cathode Ray Oscilloscope and explain how ergonomics and aesthetics design considerations are taken care of this device.

University of Mumbai
Examination 2020 under cluster Vidyavardhini's College of Engg & Tech
Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016 (CBCGS)

Examination: Third Year Semester VI

Course Code: ELX602

Course Name: Computer Communication and Networks

Time: 1 hour

Max. Marks: 50

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Note:

1. All Questions are compulsory and carry equal marks.
2. Assume suitable data wherever necessary.

Q1.	Which protocol is used to convert the IP address to Ethernet address?
Option A:	RARP
Option B:	ARP
Option C:	ICMP
Option D:	IP
Q2.	_____ cable is used for voice and data communication.
Option A:	twisted pair
Option B:	coaxial cable
Option C:	fiber optic
Option D:	shielded twisted pair
Q3.	RG-59 is used in
Option A:	radio
Option B:	thick ethernet
Option C:	thin ethernet
Option D:	cable TV
Q4.	Twisted pair cable
Option A:	can be used for Voice and data communication
Option B:	can be used for only for voice communication
Option C:	can be used for only for data communication
Option D:	Not suitable for voice or data communication
Q5.	Physical address is also called as
Option A:	Logical address
Option B:	Network address
Option C:	Hardware address
Option D:	Port address
Q6.	_____ refers to the way in which the nodes of a network are linked together.
Option A:	network
Option B:	topology

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Option C:	connection
Option D:	interconnectivity
Q7.	_____ topology has the highest reliability.
Option A:	star
Option B:	mesh
Option C:	ring
Option D:	tree
Q8.	OSI model is a _____ standard that covers all aspects of network communication.
Option A:	ANSI
Option B:	EIA
Option C:	ISO
Option D:	ICANN
Q9.	The basis for all bit oriented protocol in use today is _____
Option A:	SDLC
Option B:	PPP
Option C:	LAP
Option D:	HDLC
Q10.	If the HLEN field of IPV4 header is decimal 10 then,
Option A:	There are 10 bytes of options
Option B:	There are 40 bytes of options
Option C:	There are 10 bytes in the header
Option D:	There are 40 bytes in the header
Q11.	The IPV4 header size
Option A:	Is always 20 bytes long
Option B:	Is always 40 bytes long
Option C:	Is 20 bytes to 60 bytes long
Option D:	Depends on MTU
Q12.	The transmission mechanism used by TCP/IP is
Option A:	ARP
Option B:	IP
Option C:	RARP
Option D:	PPP
Q13.	Datagram approach and virtual circuit approach are the two popular approaches to
Option A:	Circuit switching
Option B:	Message switching
Option C:	Packet switching
Option D:	Datagram switching
Q14.	Stop and wait ARQ is the
Option A:	Flow control technique
Option B:	Error control technique

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Option C:	Congestion control technique
Option D:	Session management technique
Q15.	A receiver using stop and wait ARQ sends NAK frames numbered
Option A:	0 and 1 only
Option B:	Sequentially beginning with 0
Option C:	Sequentially beginning with 1
Option D:	The frames are not numbered
Q16.	In _____ methods the stations consult each other to find which station has the right to send data.
Option A:	Multiple access
Option B:	Random access
Option C:	Controlled access
Option D:	channelization
Q17.	The method of address aggregation is designed for
Option A:	Class full addressing
Option B:	Class less addressing
Option C:	Link addressing
Option D:	Hardware addressing
Q18.	What is the host id for address 129.3.109.6?
Option A:	129.3.109
Option B:	109.6
Option C:	129.3
Option D:	6
Q19.	The header size of ICMP message is
Option A:	16 bytes
Option B:	8 bytes
Option C:	20 bytes
Option D:	40 bytes
Q20.	To report a problem in an IP packet ____ protocol is used.
Option A:	ICMP
Option B:	ARP
Option C:	RARP
Option D:	IGMP
Q21.	Which of the following is the most commonly used data structure for implementing Dijkstra's Algorithm?
Option A:	Max priority queue
Option B:	Stack
Option C:	Circular queue
Option D:	Min priority queue

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Q22.	UDP is called a _____ protocol.
Option A:	Connection oriented, unreliable
Option B:	Connection less, unreliable
Option C:	Connection oriented, reliable
Option D:	Connection less, reliable
Q23.	TCP is a _____ protocol.
Option A:	Message oriented
Option B:	Stream oriented
Option C:	Block oriented
Option D:	Transport oriented
Q24.	The repository of information from points all over the world is
Option A:	HTTP
Option B:	HTTPS
Option C:	WWW
Option D:	DNS
Q25.	The IEEE standard for CSMA/CD is
Option A:	IEEE 802.3
Option B:	IEEE 802.11
Option C:	IEEE 802.4
Option D:	IEEE 802.5

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Program: BE Electronics Engineering
Curriculum Scheme: Revised 2016 (CBCGS)

Examination: Third Year Semester VI

Course Code: ELX603 Course Name: VLSI Design

Time: 1-hour

Max. Marks: 50

Note:

1. All Questions are compulsory and carry equal marks.
2. Assume suitable data wherever necessary.

Q1.	In saturation mode operation of MOSFET, gate to drain capacitance is zero due to _____
Option A:	Gate and drain are interconnected
Option B:	Channel length is reduced
Option C:	Inversion layer doesn't exist
Option D:	Drain is connected to ground
Q2.	N_A is acceptor impurity in the substrate of a NMOS process, after full scaling the changes in the value of N_A will be
Option A:	N_A/S
Option B:	$S*N_A$
Option C:	S^2N_A
Option D:	N_A/S^2
Q3.	The value of Power dissipation (P) in a CMOS circuit after constant voltage scaling changes to
Option A:	P/S^2
Option B:	PS^2
Option C:	PS
Option D:	P/S
Q4.	Which of the following statement is true about full scaling of a MOSFET?
Option A:	This scaling option attempts to preserve the magnitude of internal electric fields in the MOSFET, while the dimensions are scaled down by a factor of S.
Option B:	This scaling option attempts to preserve the magnitude of internal electric fields in the MOSFET, while the dimensions are scaled up by a factor of S.
Option C:	This scaling option attempts to increase the magnitude of internal electric fields in the MOSFET, while the dimensions are scaled down by a factor of S.
Option D:	This scaling option attempts to decrease the magnitude of internal electric fields in the MOSFET, while the dimensions are scaled down by a factor of S.
Q5.	The steady state power dissipation of CMOS is
Option A:	High
Option B:	Almost negligible

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Option C:	Infinite
Option D:	40W
Q6.	LAMBDA is a measure of the----- in saturation.
Option A:	Output conductance
Option B:	Input conductance
Option C:	Output Resistance
Option D:	Input transconductance
Q7.	The main advantage of implementing CMOS Inverter over Resistive load Inverter
Option A:	sharp VTC transition and better noise margin
Option B:	single power supply
Option C:	smaller overall layout area
Option D:	higher power dissipation
Q8.	The number of MOSFETs required for forming AND gate using static CMOS logic is: ---
Option A:	2
Option B:	4
Option C:	6
Option D:	8
Q9.	When $K_n > K_p$, threshold voltage of CMOS Inverter move closer to
Option A:	Zero
Option B:	Infinity
Option C:	Midpoint Value
Option D:	Supply Voltage
Q10.	In pseudo NMOS inverter, when input voltage goes slightly higher than threshold voltage, the NMOS works in -----region.
Option A:	linear
Option B:	Triode
Option C:	Saturation
Option D:	Cutoff
Q11.	In dynamic logic CMOS circuit, output enters in evaluation mode when clock $\phi = ?$
Option A:	0
Option B:	1
Option C:	20
Option D:	30
Q12.	Measure difference between pass transistor and transmission gate logic is that transmission gate has -----.
Option A:	No difference between both
Option B:	Random Failures
Option C:	Full output voltage swing
Option D:	Zero output voltage

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Q13.	Which of the following statement is true?
Option A:	The basic circuit architecture of Zipper CMOS is essentially identical to NORA CMOS, with no exception of the clock signals.
Option B:	The basic circuit architecture of Zipper CMOS is essentially identical to NORA CMOS.
Option C:	There are lot of differences between Zipper CMOS and NORA CMOS Logic.
Option D:	The basic circuit architecture of Zipper CMOS is essentially identical to NORA CMOS, with the exception of the clock signals.
Q14.	Which of the following is not a CMOS logic?
Option A:	Domino logic
Option B:	Dynamic logic
Option C:	Clocked CMOS logic
Option D:	Pre-charge logic
Q15.	Which logic is used as refreshing logic in 6T SRAM cell?
Option A:	Battery backup
Option B:	Pseudo-NMOS logic
Option C:	Separate Refreshing circuit
Option D:	Static CMOS logic
Q16.	Which element stores the charge in DRAM circuit?
Option A:	Resister
Option B:	Transistor
Option C:	Capacitor
Option D:	Inductor
Q17.	Which of the following has the capability to store the information permanently?
Option A:	RAM
Option B:	ROM
Option C:	Both RAM and ROM
Option D:	Capacitance
Q18.	The ROM (read only memory) is a _____
Option A:	Sequential circuit
Option B:	Combinational circuit
Option C:	Magnetic circuit
Option D:	Static circuit
Q19.	Which of the following statement is true?
Option A:	The complexity of circuit is more in carry look ahead than ripple carry adder circuit.
Option B:	The complexity of circuit is less in carry look ahead circuit than ripple carry adder circuit.
Option C:	The complexity of circuit is less in Manchester carry chain adder circuit than ripple carry adder circuit.
Option D:	The circuit complexity in fast adders is less than that of ripple carry adder circuit.

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Q20.	The main disadvantage of Manchester carry chain is _____
Option A:	Ripple factor
Option B:	Propagation delay
Option C:	Capacitive load
Option D:	Both propagation delay and capacitive load
Q21.	The drawback of ripple carry adder circuit is -----
Option A:	Slow
Option B:	Large area
Option C:	Both slow and Large area
Option D:	Complicated
Q22.	The connecting wires in integrated chips are called as
Option A:	Connection
Option B:	Interconnect
Option C:	Wiring
Option D:	PCB
Q23.	Cross talk in VLSI chip occurs due to -----
Option A:	Capacitive coupling between two wires
Option B:	Resistance between two wires
Option C:	Inductive coupling between two wires
Option D:	Interference between two wires
Q24.	Which type of clock distribution is preferred in Chip design?
Option A:	T-tree distribution
Option B:	I-tree distribution
Option C:	H-tree distribution
Option D:	U-tree distribution
Q25.	ESD (Electro static discharge) protection circuits have
Option A:	Current limiting resistor
Option B:	Diode clamps
Option C:	Both current limiting resistor and diode clamps
Option D:	Resistors

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Examination 2020 under cluster Vidyavardhini's College of Engg Tech
Program: BE Electronics Engineering
Curriculum Scheme: Revised 2016 (CBCGS)
Examination: Third Year Semester VI

Course Code: ELX604

Course Name: Signals and systems

Time: 1 hour

Max. Marks: 50

Note:

1. All Questions are compulsory and carry equal marks.
2. Assume suitable data wherever necessary.

Q1.	Which of the following is an example of amplitude scaling?
Option A:	Electronic amplifier
Option B:	Electronic attenuator
Option C:	Both amplifier and attenuator
Option D:	d) Adder
Q2.	Time scaling is an operation performed on _____
Option A:	Dependent variable
Option B:	Independent variable
Option C:	Both dependent and independent variable
Option D:	Neither dependent nor independent variable
Q3.	$Y(t) = x(2t)$ is _____
Option A:	Compressed signal
Option B:	Expanded signal
Option C:	Shifted signal
Option D:	Amplitude scaled signal by a factor of 2
Q4.	In discrete signal, if $y[n] = x[k*n]$ and $k > 1$ then _____
Option A:	Some samples are lost from $x[n]$
Option B:	Some samples are added to $x[n]$
Option C:	It has no effect on samples
Option D:	Samples will be increased with factor k
Q5.	$y(t) = \sin(x(t-1))$: Comment on its memory aspects.
Option A:	Having memory
Option B:	Needn't have memory
Option C:	Memoryless system
Option D:	Time invariant system
Q6.	Construct the inverse system of $y(t) = 2x(t)$
Option A:	$y(t) = 0.5x(t)$

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Option B:	$y(t) = 2x(t)$
Option C:	$y(2t) = x(t)$
Option D:	d) $y(t) = x(2t)$
Q7.	Comment on the causality of $y[n] = x[-n]$.
Option A:	Time invariant
Option B:	Causal
Option C:	Non causal
Option D:	Time varying
Q8.	Comment on the linearity of $y[n] = n*x[n]$.
Option A:	Linear
Option B:	Only additive
Option C:	Not scalable
Option D:	Non linear
Q9.	Which of the following systems is linear?
Option A:	$y(t) = \sin(x(t))$
Option B:	$y(t) = \log(x(t))$
Option C:	$y(t) = \cos(x(t))$
Option D:	$y(t) = dx(t)/dt$
Q10.	Which of the following systems is stable?
Option A:	$y(t) = \log(x(t))$
Option B:	$y(t) = \exp(x(t))$
Option C:	$y(t) = \sin(x(t))$
Option D:	$y(t) = tx(t) + 1$
Q11.	For what value of k, will the following system be time invariant? $y(t) = x(t) + x(kt) - x(2t) + x(t-1)$
Option A:	1
Option B:	2
Option C:	3
Option D:	2.5
Q12.	In a continuous-time physical system, memory is directly associated with _____
Option A:	Storage registers
Option B:	Time
Option C:	Storage of energy
Option D:	Number of components in the system
Q13.	The convolution of a discrete time system with a delta function gives
Option A:	The square of the system
Option B:	The system itself
Option C:	The derivative of the system
Option D:	The integral of the system

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Q14.	How is a time domain system analyzed?
Option A:	Study of a system in accordance to changes in its inputs over time
Option B:	Study of a system in accordance to changes in its over time
Option C:	Study of a system in accordance to changes in its overall structure over time
Option D:	Study of a system in accordance to how a system change itself overall in a time
Q15.	What is the frequency domain?
Option A:	Analysis of signals in a frequency range
Option B:	Analysis of signals in their bandwidth
Option C:	Analysis of a signal with respect to its frequency
Option D:	Study of a system in accordance to changes in its overall frequency
Q16.	What are the mathematical tools to convert a system from a time domain to frequency domain?
Option A:	Fourier series, Fourier transform, Laplace transform, Z-transform
Option B:	Fourier series only
Option C:	Fourier series and Laplace transform only
Option D:	Fourier series, Fourier transform and Laplace transform only
Q17.	What is the rule $h^*(x+y) = (y+x)*h$ called?
Option A:	Commutativity rule
Option B:	Associativity rule
Option C:	Distributive rule
Option D:	Transitive rule
Q18.	When do DTFT and ZT are equal?
Option A:	When $\sigma = 0$
Option B:	When $r = 1$
Option C:	When $\sigma = 1$
Option D:	When $r = 0$
Q19.	Find the Z-transform of $u(-n)$.
Option A:	$\frac{1}{1-z}$
Option B:	$\frac{1}{1+z}$
Option C:	$\frac{z}{1-z}$
Option D:	$\frac{z}{1+z}$
Q20.	The z-transform of $\{3,0,0,0,0,6,1,-4\}$ (1 as the reference variable) is _____
Option A:	$3z^5 + 6 + z^{-1} - 4z^{-2}, 0 \leq z < \infty$
Option B:	$3z^5 + 6 + z^{-1} - 4z^{-2}, 0 < z < \infty$
Option C:	$3z^5 + 6 + z - 4z^{-2} 0 < z < \infty$

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Option D:	$3z^5 + 6 + z^{-1} - 4z^{-2}, 0 \leq z < \infty$
Q21.	Given the z-transform pair $X[n] \leftrightarrow \frac{32}{z^2 - 16}, z < 4$ The z-transform of the signal x [n-2] is _____
Option A:	$\frac{z^4}{z^2 - 16}$
Option B:	$\frac{(z + 2)^2}{(z + 2)^2 - 16}$
Option C:	$\frac{1}{(z^2 - 16)}$
Option D:	$\frac{(z - 2)^2}{(z - 2)^2 - 16}$
Q22.	Find the Z-transform of the causal sequence x(n) = {1,0,-2,3,5,4}. (1 as the reference variable)
Option A:	$1 - 2z^{-2} + 3z^{-3} + 5z^{-4} + 4z^{-5}$
Option B:	$1 - 2z^2 + 3z^3 + 5z^4 + 4z^5$
Option C:	$z^{-1} - 2z^2 + 3z^3 + 5z^4 + 4z^5$
Option D:	$z - 2z^3 + 3z^4 + 5z^5 + 4z^6$
Q23.	Given a discrete time signal x[k] defined by x[k] = 1, for $-2 \leq k \leq 2$ and 0, for $ k > 2$. Then, y[k] = x[3k-2] is _____
Option A:	y[k] = 1, for k = 0, 1 and 0 otherwise
Option B:	y[k] = 1, for k = 1 and -1 for k=-1
Option C:	y[k] = 1, for k = 0, 1 and -1 otherwise
Option D:	y[k] = 1, for k = 0, 1 and 0 otherwise
Q24.	A Discrete signal is said to be even or symmetric if X(-n) is equal to _____
Option A:	X(n)
Option B:	0
Option C:	-X(n)
Option D:	-X(-n)
Q25.	The Fourier transform of the signal $\delta(t+1) + \delta(t-1)$ is _____
Option A:	$\frac{2}{1 + j\omega}$
Option B:	$\frac{2}{1 - j\omega}$

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Option C:	$2 \cos \omega$
Option D:	$2 \sin \omega$

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Examination 2020 under cluster Vidyavardhini's College of Engg Tech
Program: BE Electronics Engineering
Curriculum Scheme: Revised 2016 (CBCGS)
Examination: Third Year Semester VI

Course Code: ELXDLO6021

Course Name: Microwave Engineering

Time: 1 hour

Max. Marks: 50

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Note:

1. All Questions are compulsory and carry equal marks.
2. Assume suitable data wherever necessary.

Q1.	When the propagation constant has negative sign in imaginary part it signifies wave in TWTA.
Option A:	Forward
Option B:	Constant
Option C:	Infinite
Option D:	Backward
Q2.	The dominant mode of rectangular waveguide is
Option A:	TE ₀₁
Option B:	TM ₁₁
Option C:	TE ₁₀
Option D:	TM ₀₁
Q3.	For radius r=5 cm air filled circular waveguide with parameter X ₁₁ '= 1.841 what will be the cut-off frequency for dominant TE ₁₁ mode?
Option A:	1.758 GHz
Option B:	0.967 GHz
Option C:	2.675 GHz
Option D:	3.954 GHz
Q4.	For four port directional coupler, identify correct relation, where I=Isolation, C= Coupling, D= Directivity. Note that I, C, D are in dB.
Option A:	D=I+C
Option B:	I=C+D
Option C:	C=D+I
Option D:	I=C*D
Q5.	Identify correct statement in relation with two cavity klystron amplifier and travelling wave tube amplifier (TWT) (C)
Option A:	In two cavity klystron amplifier RF field is moving & electron beam is stationary whereas in TWT both are stationary
Option B:	In two cavity klystron amplifier RF field is moving & electron beam is stationary whereas in TWT both are moving
Option C:	In two cavity klystron amplifier RF field is stationary & electron beam is moving

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	whereas in TWT both are moving
Option D:	In two cavity klystron amplifier RF field is stationary & electron beam is moving whereas in TWT RF field is moving & electron beam is stationary
Q6.	Which is not a mode of Gunn Diode?
Option A:	Limited Space Charge
Option B:	Drift Space Mode
Option C:	Transit Time Domain
Option D:	Quenched Domain
Q7.	H-plane Tee is also known as
Option A:	Shunt Tee
Option B:	Series Tee
Option C:	Magic Tee
Option D:	Hybrid Tee
Q8.	Hybrid ring is also called as.....
Option A:	TEE junction
Option B:	Directional coupler
Option C:	Phase shifter
Option D:	Rat race circuit
Q9.	Toroidal cavity, Radial cavities are all examples ofcavities.
Option A:	Re-entrant
Option B:	hybrid
Option C:	TEE
Option D:	slotted
Q10.	Circulator allows signals to propagate in.....port.
Option A:	diagonal
Option B:	forward adjacent
Option C:	opposite
Option D:	same
Q11.	TWTA is a amplifier.
Option A:	narrowband
Option B:	broadband
Option C:	attenuator
Option D:	parametric
Q12.	Value of bunching parameter X is..... for two cavity klystron.
Option A:	2.408
Option B:	1.732
Option C:	1.414
Option D:	1.841
Q13.	Velocity modulation takes place in.....of two cavity klystron.

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Option A:	buncher
Option B:	catcher
Option C:	cathode
Option D:	collector
Q14.	For $2\text{cm} \times 4\text{cm}$ rectangular waveguide filled with dielectric constant $\epsilon_r = 2.25$, what will be the cut-off frequency for dominant TE_{10} mode?
Option A:	1.75 GHz
Option B:	2.75 GHz
Option C:	3.75 GHz
Option D:	2.50 GHz
Q15.	Scattering parameter S_{12} signifies power flow from.....
Option A:	Port 2 to port 1
Option B:	Port 1 to port 2
Option C:	Port 1 to port 1
Option D:	Port 2 to port 2
Q16.	GUNN diode is a resistance device.
Option A:	Negative
Option B:	positive
Option C:	imaginary
Option D:	constant
Q17.	Gyrator is a device that produces a phase shift ofbetween the input and output.
Option A:	90°
Option B:	180°
Option C:	45°
Option D:	270°
Q18. microwave diode can be used as a switch.
Option A:	PIN Diode
Option B:	TRAPATT
Option C:	GUNN
Option D:	IMPATT
Q19.	Which diode of the following is most noisy diode?
Option A:	TUNNEL
Option B:	Varactor Diode
Option C:	IMPATT
Option D:	Schottky Diode
Q20.	In microwave power measurement using bolometer, the principle of working is the variation
Option A:	Induction with absorption of power

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Option B:	Resistance with the absorption of power
Option C:	Capacitance with absorption of power
Option D:	Cavity dimensions with heat generated by power
Q21.	Measurement of frequency can be done using.....
Option A:	Frequency meter
Option B:	Power meter
Option C:	Attenuator
Option D:	Directional coupler
Q22.	The value of dielectric constant of hollow metallic waveguide will be.....
Option A:	0
Option B:	1
Option C:	infinity
Option D:	4.33
Q23.	Zero property of S matrix involves multiplication of element of any row or column to it's element of row or column.
Option A:	adjacent
Option B:	same
Option C:	Zero
Option D:	infinity
Q24.	Microwave component immediately connected after reflex klystron in microwave bench set is
Option A:	Slotted waveguide
Option B:	Frequency meter
Option C:	Attenuator
Option D:	Isolator
Q25.	Guide wavelength in laboratory is measured using
Option A:	Magic tee
Option B:	Directional coupler
Option C:	Slotted waveguide with probe
Option D:	Isolator

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Examination 2020 under cluster Vidyavardhini's College of Engg & Tech
Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016 (CBCGS)

Examination: Third Year Semester VI

Course Code: ELX DLO6022 Course Name: Electronic Product Design

Time: 1 hour

Max. Marks: 50

Q1.	_____ deal with the mental processes and capabilities of human being to process information and interact with data.
Option A:	Physical Ergonomics
Option B:	Cognitive Ergonomics
Option C:	Organizational Ergonomics
Option D:	Test cases
Q2.	The purpose of shielding is to control _____ from one region to the other.
Option A:	the propagation of electric field only
Option B:	the propagation of magnetic field only
Option C:	the propagation of electric field and magnetic field
Option D:	the propagation of either electric field or magnetic field
Q3.	Which among the below mentioned assertions is not a way of cross-talk reduction while designing digital PCBs?
Option A:	Decrease in the distance between conductors
Option B:	Shielding of clock lines with guard strips
Option C:	Reduction in the loop area of circuits
Option D:	Avoid running of parallel traces for longer distances especially for asynchronous signals
Q4.	The _____ model describes the physical architecture of the system based on real components such as microprocessors, arrayed logics, special purpose processors, analog and digital components, and the many interconnections between them.
Option A:	Architectural
Option B:	Functional
Option C:	Waterfall
Option D:	Prototype
Q5.	Black box testing is also known as _____.
Option A:	Clear box testing
Option B:	Structural testing
Option C:	Functional testing
Option D:	Glass box testing.
Q6.	IEEE Standard for Software Test Documentation defines _____ as “a

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	document describing the scope, approach, resources and schedule of intended testing activities”
Option A:	Test Planning
Option B:	Black box testing
Option C:	White box testing
Option D:	Grey box testing
Q7.	Black box tests are _____driven and white box tests are _____driven.
Option A:	Logic, data
Option B:	Data, logic
Option C:	Data, data
Option D:	Logic, logic
Q8.	Test cases are created in which phase?
Option A:	Test Planning
Option B:	Test Specification
Option C:	Test Requirement
Option D:	Test Configuration
Q9.	Risk management is responsibility of the
Option A:	Investor
Option B:	customer
Option C:	Project team
Option D:	Developer
Q10.	Risk Exposure can be defined as:
Option A:	Probability + impact
Option B:	Probability / impact
Option C:	Impact/probability
Option D:	Probability × impact
Q11.	A step in the waterfall model that involves a meeting with the customer to understand the requirements.
Option A:	Implementation
Option B:	Requirement Analysis and Gathering
Option C:	System design
Option D:	Integration and Testing
Q12.	The presence of error at the time of execution of the software is
Option A:	Bug
Option B:	Error
Option C:	Fault
Option D:	Failure
Q13.	End result of Software Requirement Analysis is _____.
Option A:	Functional and Behavioral

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Option B:	Architectural and Structural
Option C:	Usability and Reliability
Option D:	Algorithmic and Data Structure
Q14.	_____ is a relative measure of a device, or a system's propensity to be disrupted or damaged by EMI exposure to an incident field or signal.
Option A:	Containment
Option B:	Immunity
Option C:	Susceptibility
Option D:	Suppression
Q15.	What effects can be observed if the separate power and ground planes are provided with large conducting surfaces for better decoupling in PCB layouts?
Option A:	Increase in self inductance
Option B:	Reduction in self inductance
Option C:	Stability in self inductance
Option D:	Increase in mutual inductance
Q16.	The drawback of using ----- is that the outer layers of the PCB can occasionally radiate RF energy to the environment, without the protection of a plane on both sides.
Option A:	Microstrip
Option B:	Stripline
Option C:	Grounding
Option D:	Image planes
Q17.	Which statement is not correct with respect to image plane?
Option A:	An image plane is a layer of copper or similar conductive internal to a PCB.
Option B:	This layer may be identified as a voltage plane, ground plane, or 0 V reference plane physically adjacent to a circuit or signal routing layer.
Option C:	An image plane reduces ground noise voltage.
Option D:	Image planes provide a high-impedance path for RF currents to return to their source.
Q18.	The distance spacing between ground stitch locations in PCB should not exceed ____ of the highest frequency, or harmonic of concern
Option A:	$\lambda/2$
Option B:	$\lambda/4$
Option C:	$\lambda/20$
Option D:	$\lambda/10$
Q19.	What is not true with respect to Verification:
Option A:	It is Static testing
Option B:	It is Dynamic testing
Option C:	It is the process of checking that a software achieves its goal without any bugs
Option D:	It is the process to ensure whether the product that is developed is right or not.
Q20.	Which of the following elements comprise of all of the passive devices?
Option A:	Transformers, TRIACs and DIACs

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Option B:	Vacuum Tubes, SCRs and Diodes
Option C:	Resistors, Capacitors and SCRs
Option D:	Transformers, Inductors and Diodes
Q21.	An ideal op-amp requires infinite bandwidth because
Option A:	Signals can be amplified without attenuation
Option B:	Output common-mode noise voltage is zero
Option C:	Output voltage occurs simultaneously with input voltage changes
Option D:	Output can drive infinite number of devices
Q22.	Which among the below mentioned types of redundancy exhibits maximum failure rate?
Option A:	Cold standby
Option B:	Warm
Option C:	Hot or Active
Option D:	Tepid
Q23.	The source listings, schematics, and engineering notebooks are which type of document?
Option A:	Instructions
Option B:	Reviews and reports
Option C:	Design documents
Option D:	Plans
Q24.	Which of the following should describe the technical terms used in the document?
Option A:	Preface
Option B:	Glossary
Option C:	Acknowledgement
Option D:	Index
Q25.	Liability usually refers to a _____, while accountability refers to a _____.
Option A:	Hardware, software
Option B:	social responsibility, legal responsibility
Option C:	Software, hardware
Option D:	legal responsibility, social responsibility

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Examination 2020 under cluster Vidyavardhini's College of Engg Tech
Program: BE Electronics Engineering
Curriculum Scheme: Revised 2016 (CBCGS)
Examination: Third Year Semester VI

Course Code: ELXDLO6023

Course Name: Wireless Communication

Time: 1 hour

Max. Marks: 50

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Note:

1. All Questions are compulsory and carry equal marks.
2. Assume suitable data wherever necessary.

Q1.	Frequency reuse can be maximized by-----
Option A:	Increasing the size of the cells
Option B:	Decreasing the size of the cells
Option C:	Increasing the size of the clusters
Option D:	Increasing the number of users
Q2.	Cells sectorization is done to -----
Option A:	Accommodate more traffic
Option B:	Accommodate more area
Option C:	Save power
Option D:	Increase frequency reuse
Q3.	If the cluster size is increased
Option A:	The inter-channel interference reduces
Option B:	The transmission power increases
Option C:	The co-channel interference reduces
Option D:	The number of reuse frequency increases
Q4.	Hard handover means -----
Option A:	Handing over the cell to another mobile
Option B:	Changing over the communication channel
Option C:	Increase in power while moving to another base station
Option D:	Handing over the call to an MSC
Q5.	Which of the following angle is suitable for sectorization?
Option A:	45°
Option B:	60°
Option C:	100°
Option D:	80°
Q6.	Small scale fading describes the ----- in the amplitude and phase of the signal.
Option A:	Rapid fluctuations
Option B:	instantaneous fluctuations

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Option C:	slow fluctuations
Option D:	Small fluctuations
Q7.	Free space propagation model is used to predict which of these?
Option A:	Transmitted power
Option B:	Gain of receiver
Option C:	Received signal strength
Option D:	Gain of transmitter
Q8.	The Direct sequence spread spectrum (DSSS) exhibits mainly -----characteristic.
Option A:	Bandwidth reduction
Option B:	Power control
Option C:	Correlation
Option D:	Anti jamming
Q9.	The multiple access techniques :TDMA-FDMA together is implemented in which of these ?
Option A:	GSM
Option B:	IS-95
Option C:	AMPS
Option D:	GPRS
Q10.	The effect of spread spectrum modulation is that the bandwidth of the spreaded signal -----
Option A:	Remains constant
Option B:	Increases significantly
Option C:	Increases marginally
Option D:	decreases
Q11.	Which of the following multiple access methods allows all users to simultaneously use the whole bandwidth?
Option A:	TDMA
Option B:	FDMA
Option C:	CDMA
Option D:	SDMA
Q12.	Which of these is the reverse channel in IS-95 , CDMA system?
Option A:	Pilot channel
Option B:	Synchronization channel
Option C:	Paging channel
Option D:	Access channel
Q13.	In IS-95 system , the synchronization channel is assigned the Walsh code ----

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Option A:	W_0
Option B:	W_1
Option C:	W_{32}
Option D:	W_{63}
Q14.	The flat fading channel is one in which -----
Option A:	BW of the signal $>$ bw of the channel
Option B:	BW of the signal $<$ bw of the channel
Option C:	BW of the signal = bw of the channel
Option D:	BW of the signal + bw of the channel
Q15.	The Doppler shift is ----when mobile station(MS) is moving away from the direction of arrival of the wave
Option A:	Positive
Option B:	Negative
Option C:	exponential
Option D:	constant
Q16.	Which of these identifier in GSM system is used to validate the MS as a valid subscriber?
Option A:	IMEI
Option B:	MSRN
Option C:	IMSI
Option D:	LAI
Q17.	A single time slot in TDMA frame of GSM has -----duration.
Option A:	577 micro seconds
Option B:	4.615 milli seconds
Option C:	120 milli seconds
Option D:	6.12 seconds
Q18.	The uplink frequency of GSM is
Option A:	1800-1900MHz
Option B:	935-960 MHz
Option C:	890- 915kHz
Option D:	890-915 MHz
Q19.	The permanent database of all registered subscribers is maintained in the ----
Option A:	VLR
Option B:	AUC
Option C:	EIR
Option D:	HLR
Q20.	Which of these is a dedicated control channel in GSM?
Option A:	AGCH
Option B:	SACCH
Option C:	PCH

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Option D:	RACH
Q21.	Which of these is an air interface between BTS and BSC?
Option A:	Um
Option B:	A
Option C:	A'bis
Option D:	Iuc
Q22.	The IS-95 CDMA system, reverse channel employs ----- digital modulation technique.
Option A:	BPSK
Option B:	Offset QPSK
Option C:	OFDM
Option D:	QPSK
Q23.	Which of the following systems is a 3G system?
Option A:	AMPS
Option B:	EDGE
Option C:	DECT
Option D:	UMTS
Q24.	GPRS supports -----
Option A:	voice
Option B:	data
Option C:	Voice and data
Option D:	video
Q25.	The transmission schemes for uplink and downlink direction in LTE are
Option A:	OFDMA & SC-FDMA
Option B:	CDMA & FDD
Option C:	TDMA & FDMA
Option D:	TDMA & FDD

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Examination 2020 under cluster Vidyavardhini's College of Engg & Tech
Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016 (CBCGS)

Examination: Third Year Semester VI

Course Code: ELXDLO6024 Course Name: Computer Organization and Architecture

Time: 1 hour

Max. Marks: 50

Note:

1. All Questions are compulsory and carry equal marks.
2. Assume suitable data wherever necessary.

Q1.	The interval from the time of submission of a process to the time of completion is termed as _____
Option A:	Waiting Time
Option B:	Turnaround Time
Option C:	Response Time
Option D:	Throughput
Q2.	If a RAM chip has n address input lines then it can access memory locations up to
Option A:	$2^{(n-1)}$
Option B:	$2^{(n+1)}$
Option C:	2^n
Option D:	2^{2n}
Q3.	Restoring division and Non-restoring division algorithm are based on
Option A:	Addition/subtraction and shift category
Option B:	Addition category
Option C:	Subtraction category
Option D:	Shift category
Q4.	What process happens in an instruction cycle
Option A:	It is the process of fetching, decoding and executing the instructions
Option B:	It is the process of only decoding.
Option C:	It is the process of preparing instructions.
Option D:	It is the process of encoding instructions.
Q5.	The CISC architecture stands for _____
Option A:	Computer Instruction Set Complement
Option B:	Complete Instruction Set Complement
Option C:	Computer Indexed Set Components
Option D:	Complex Instruction set Computer

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Q6.	If the control signals are generated by combinational logic, then they are generated by a type of _____ controlled unit.
Option A:	Logic
Option B:	Software
Option C:	Hardwired
Option D:	Micro programmed
Q7.	Delay Element method is an example _____.
Option A:	Hardwired control unit design
Option B:	Hardcore control unit design
Option C:	Microprogrammed control unit design
Option D:	Macroprogrammed control unit design
Q8.	Each of the control steps in the control sequence of an instruction defines the unique combination of _____ in the control word.
Option A:	0's and 1's
Option B:	0's
Option C:	controls
Option D:	signals
Q9.	In computer performance MIPS stands for
Option A:	Millions Of Instructions Per Second
Option B:	Millions Of Floating Point Instructions Per Second
Option C:	Millions Of Instructions Per System
Option D:	Millions Of Floating Point Instructions Per System
Q10.	In Memory Interleaving, the lower bits of the address is used to
Option A:	Get the data
Option B:	Get the address of the module
Option C:	Get the address of the data within the module
Option D:	Get the address of the register within the module
Q11.	In memory Hierarchy going from up to down level
Option A:	Increasing cost / bit
Option B:	Decreasing access time
Option C:	Increasing frequency of access
Option D:	Increasing capacity
Q12.	The write-through procedure is used _____
Option A:	To write onto the memory directly
Option B:	To write and read from memory simultaneously
Option C:	To write directly on the memory and the cache simultaneously
Option D:	To write onto the cache directly
Q13.	The correspondence between the main memory blocks and those in the cache is given by

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Option A:	Hash function
Option B:	Mapping function
Option C:	Locale function
Option D:	Assign function
Q14.	The number of successful accesses to memory stated as a fraction is called as _____
Option A:	Hit rate
Option B:	Miss rate
Option C:	Success rate
Option D:	Access rate
Q15.	The advantage of I/O mapped devices to memory mapped devices is
Option A:	The former offers faster transfer of data
Option B:	The devices connected using I/O mapping have a bigger buffer place
Option C:	The devices have to deal with fewer address lines
Option D:	No advantages as such
Q16.	PCI stands for
Option A:	Peripheral Component Interconnect
Option B:	Peripheral Computer Internet
Option C:	Processor Computer Interconnect
Option D:	Processor Cable Interconnect
Q17.	Which of the following is the fastest method of bus arbitration?
Option A:	Daisy chaining
Option B:	Independent request
Option C:	Polling
Option D:	Priority checking
Q 18.	The SCSI BUS uses _____ arbitration.
Option A:	Centralised
Option B:	Distributed
Option C:	Daisy Chain
Option D:	Hybrid
Q 19.	Data hazards occur when:
Option A:	Pipeline changes the order of read/write access to operands
Option B:	Greater performance loss
Option C:	Machine size is limited
Option D:	Some functional unit is not fully pipelined
Q 20.	_____ leads to concurrency.
Option A:	Serial processing
Option B:	Parallelism
Option C:	Distribution
Option D:	Serialization

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Q 21.	A given application is run on a 64 processor machine and that 70% of the application is parallelizable then the expected speedup improvement is:
Option A:	3.50
Option B:	3.22
Option C:	2.33
Option D:	2.89
Q 22.	In super-scalar processors, _____ mode of execution is used.
Option A:	In-order
Option B:	Post order
Option C:	Out of order
Option D:	Past order
Q 23.	The set of loosely connected computers are called as _____
Option A:	Cluster
Option B:	WAN
Option C:	Workstation
Option D:	LAN
Q 24.	The time lost due to the branch instruction is often referred to as _____
Option A:	Latency
Option B:	Branch penalty
Option C:	Delay
Option D:	Stalling
Q 25.	Uniform Memory Access is applicable for
Option A:	Real time applications
Option B:	Real-time applications and time-critical applications.
Option C:	General purpose applications and time-sharing applications
Option D:	Time critical applications

Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016

Examination: Third Year Semester VI

Course Code: ELX602 and Course Name: Computer Communication and Networks

Time: 1 hour

Max. Marks: 50

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Note to the students:- All the Questions are compulsory and carry equal marks .

Q1.	TCP/IP model does not have _____ layer but OSI model have this layer.
Option A:	Session layer
Option B:	Transport layer
Option C:	Application layer
Option D:	Network layer
Q2.	Which layer is used to link the network support layers and user support layers?
Option A:	Session layer
Option B:	Data link layer
Option C:	Transport layer
Option D:	Network layer
Q3.	Which address is used to identify a process on a host by the transport layer?
Option A:	Physical address
Option B:	logical address
Option C:	Port address
Option D:	Specific address
Q4.	_____ cable consists of inner copper core and a second conducting outer sheath
Option A:	Twisted pair
Option B:	Coaxial cable
Option C:	Fiber optic
Option D:	Shielded twisted pair
Q5.	In an optical fiber the inner core is _____ the cladding
Option A:	Denser than
Option B:	less dense than
Option C:	The same density as
Option D:	Another name for

Q6.	The inner core of optical fiber is _____ in composition
Option A:	Glass or plastic
Option B:	Copper
Option C:	Bimetallic
Option D:	liquid
Q7.	RG-59 is used in
Option A:	Radio
Option B:	Thick Ethernet
Option C:	Thin Ethernet
Option D:	Cable TV
Q8.	We add r redundant bits to each block to make the length $n = k + r$. The resulting n-bit blocks are called _____
Option A:	Blockword
Option B:	Dataword
Option C:	Code word
Option D:	Word
Q9.	In a linear block code, the _____ of any two valid Codewords creates another valid codeword
Option A:	XORing
Option B:	ORing
Option C:	ANDing
Option D:	NOTing
Q10.	In _____, the station configuration is unbalanced. We have one primary station and multiple secondary stations
Option A:	ARM
Option B:	NBM
Option C:	NRM
Option D:	ABM
Q11.	The checksum of 1111 and 1111 is
Option A:	1111
Option B:	0000
Option C:	1110
Option D:	0111
Q12.	Most packet switches use this principle _____
Option A:	Stop and wait
Option B:	Store and forward
Option C:	Store and wait
Option D:	Stop and forward

Q13.	If there are N routers from source to destination, the total end to end delay in sending packet P(L-> number of bits in the packet R-> transmission rate) is equal to _____
Option A:	N
Option B:	$(N*L)/R$
Option C:	$(2N*L)/R$
Option D:	L/R
Q14.	The required resources for communication between end systems are reserved for the duration of the session between end systems in _____ method.
Option A:	Packet switching
Option B:	Circuit switching
Option C:	Line switching
Option D:	Frequency switching
Q15.	In _____ systems, resources are allocated on demand.
Option A:	Packet switching
Option B:	Circuit switching
Option C:	line switching
Option D:	Frequency switching
Q16.	Switching in the internet is done by using the datagram approach in packet switching at the _____
Option A:	Data link layer
Option B:	Network Layer
Option C:	Transport layer
Option D:	Physical Layer
Q17.	What is the host id for address 130.8.119.1
Option A:	8.119.1
Option B:	119.1
Option C:	1
Option D:	130.8.119
Q18.	The network address in class A without subnetting has _____ zeros in decimal notation.
Option A:	3
Option B:	2
Option C:	1
Option D:	0
Q19.	Which of the following is false with respect to UDP?
Option A:	Connection-oriented
Option B:	Unreliable
Option C:	Transport layer protocol
Option D:	Low overhead

Q20.	What is the header size of a UDP packet?
Option A:	8 bytes
Option B:	8 bits
Option C:	16 bytes
Option D:	124 bytes
Q21. addresses use 21 bits for the and 8 bits for the portion of the IP address for TCP/IP network.
Option A:	Class A
Option B:	Class B
Option C:	Class C
Option D:	Class D
Q22.	If you use either Telnet or FTP, which is the highest layer you are using to transmit data?
Option A:	Application
Option B:	Presentation
Option C:	Session
Option D:	Transport
Q23.	In one of the pairs of protocols given below, both the protocols can use multiple TCP connections between the same client and the server. Which one is that?
Option A:	HTTP,FTP
Option B:	HTTP,TELNET
Option C:	FTP,SMTP
Option D:	HTTP,SMTP
Q24.	Mostly _____ is used in wireless LAN.
Option A:	Time division multiplexing
Option B:	Orthogonal frequency division multiplexing
Option C:	Space division multiplexing
Option D:	Channel division multiplexing
Q25.	The wireless LAN specification is defined by IEEE called _____ which covers the data link and physical layer
Option A:	IEEE 802.2
Option B:	IEEE 802.11
Option C:	IEEE 802.3
Option D:	IEEE 802.5

Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016

Examination: Third Year Semester VI

Course Code: ELX603 and Course Name: VLSI DESIGN

Time: 1 hour

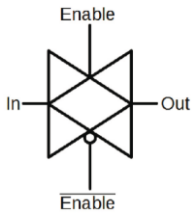
Max. Marks: 50

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Note to the students:- All the Questions are compulsory and carry equal marks .

Q1.	In case of bipolar technology-----parameter is better compared to CMOS technology?
Option A:	static power dissipation
Option B:	noise margin
Option C:	drive current
Option D:	input impedance
Q2.	In cut-off mode, the gate-to-source (C_{gs}) and the gate-to-drain (C_{gd}) MOSFET capacitances are both equal to-----.
Option A:	zero
Option B:	infinite
Option C:	0.5
Option D:	0.66
Q3.	In full scaling, the power dissipation of the MOSFET transistor will be reduced by the factor -----.
Option A:	s
Option B:	s^2
Option C:	s^3
Option D:	s^4
Q4.	The value of scaling factor 's' is -----.
Option A:	less than one

Option B:	equal to one
Option C:	greater than one
Option D:	equal to 0.1
Q5.	MOSFET LEVEL 1 (MOS1) is described by -----.
Option A:	a semi-empirical model
Option B:	a square-law current-voltage characteristic
Option C:	a detailed analytical MOSFET model
Option D:	a Berkeley Short-Channel IGFET Model
Q6.	In case of CMOS inverter, steady state power dissipation is -----.
Option A:	infinite
Option B:	virtually negligible
Option C:	very large value
Option D:	is more than resistive load inverter
Q7.	In case of CMOS inverter, when $V_{in} < V_{t0,n}$ and $V_{out} = V_{OH}$, nMOS and pMOS operating in-----mode respectively.
Option A:	cut-off and linear
Option B:	saturation and linear
Option C:	saturation
Option D:	linear and cut-off
Q8.	Consider a CMOS Inverter circuit with the following parameters: $V_{DD} = 3.3 \text{ V}$ $V_{T0,n} = 0.6 \text{ V}$, $V_{T0,p} = -0.7 \text{ V}$ $K_n = 200 \mu\text{A}/\text{V}^2$, $K_p = 80 \mu\text{A}/\text{V}^2$ Calculate V_{IL}
Option A:	1.08 V

Option B:	1.55 V
Option C:	3.3 V
Option D:	0 V
Q9.	Identify type of passive load inverter from the following list.
Option A:	Enhancement Load nMOS Inverter
Option B:	Depletion Load nMOS Inverter
Option C:	Resistive Load nMOS Inverter
Option D:	CMOS Inverter
Q10.	For symmetric CMOS inverter-----.
Option A:	$(K_n/K_p) = 0.4$
Option B:	$(K_n/K_p) = 4$
Option C:	$(K_n/K_p) = 1.5$
Option D:	$(K_n/K_p) = 1$
Q11.	Identify the following logic symbol. 
Option A:	Pass Transistor
Option B:	CMOS
Option C:	AND gate
Option D:	Transmission Gate
Q12.	Name the following circuit implemented using Transmission Gate.

Option A:	2:1 Decoder
Option B:	4:1 Mux
Option C:	1:2 De-mux
Option D:	2:1 Mux
Q13.	Which statement is true for NORA logic?
Option A:	In this logic style the static CMOS inverters are replaced by the dynamic logic circuits using nMOSFETs.
Option B:	In this logic style the static CMOS inverters are replaced by the dynamic logic circuits using pMOSFETs and nMOSFETs.
Option C:	In this logic style the static CMOS inverters are replaced by the C ² MOS logic circuits using pMOSFETs.
Option D:	In this logic style the static CMOS inverters are replaced by the dynamic logic circuits using pMOSFETs
Q14.	To implement N input static CMOS logic circuit requires ----- number of transistors.
Option A:	N
Option B:	N/2
Option C:	2N
Option D:	N+1
Q15.	Domino logic is same as ----- with static inverter at the output terminal.
Option A:	clocked CMOS logic
Option B:	dynamic CMOS logic

Option C:	gate logic
Option D:	switch logic
Q16.	Which of the following semiconductor memory uses a MOSFET and a capacitor as its memory cell?
Option A:	ROM
Option B:	DRAM
Option C:	DROM
Option D:	SRAM
Q17.	Which is true from the following for Flash Memory?
Option A:	It uses neither control gate nor floating gate
Option B:	It uses control gate only
Option C:	It uses floating gate only
Option D:	It uses both control gate and floating gate
Q18.	Which circuit is used for read operation in SRAM?
Option A:	Attenuator
Option B:	Stabilizer
Option C:	Filter
Option D:	Sense Amplifier
Q19.	Following is the figure of MOS NOR ROM Cell Array, If $R_1=R_2=R_3=0$ and $R_4=1$, what value is available at C1, C2, C3, C4?

Option A:	0101
Option B:	1100
Option C:	0110
Option D:	1001
Q20.	The ripple carry adder is slow as-----.
Option A:	the carry bits are transferred through every stage
Option B:	the sum bits are transferred through every stage
Option C:	the sum and carry bits are transferred through every stage
Option D:	the carry bits are transferred through alternate stage
Q21.	Carry generator in full adder has expression -----.
Option A:	$g_i = a_i \cdot b_i$
Option B:	$g_i = a_i + b_i$
Option C:	$g_i = a_i - b_i$
Option D:	$g_i = a_i \div b_i$
Q22.	The Manchester carry scheme is based on building a switch-logic network for the basic equation-----.

Option A:	$C_{i+1} = g_i + c_i$
Option B:	$C_{i+1} = g_i + g_i \cdot c_i$
Option C:	$C_{i+1} = g_i + p_i \cdot c_i$
Option D:	$C_{i+1} = g_i \cdot p_i \cdot c_i$
Q23.	The high speed adder can be implemented by using ----- scheme.
Option A:	sum skip
Option B:	carry save
Option C:	propagate skip
Option D:	generate select
Q24.	An ideal on chip clock distribution network would be the ----- structure.
Option A:	Y-tree
Option B:	H-tree
Option C:	A-tree
Option D:	L-tree
Q25.	The Switching Power (Dynamic power) Dissipation in CMOS is equal to-----.
Option A:	$P_{dynamic} = C_{load} \cdot V_{dd}^2 \cdot T$
Option B:	$P_{dynamic} = C_{load} \cdot V_{dd}^2$
Option C:	$P_{dynamic} = C_{load} \cdot f$
Option D:	$P_{dynamic} = C_{load} \cdot V_{dd}^2 \cdot f$

Program: BE Electronics Engineering

Curriculum Scheme: Revised 2016

Examination: Third Year Semester VI

Course Code: ELX 604 and Course Name: Signals and Systems

Time: 1hour

Max. Marks: 50

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3009_R16_ETRX_VI_ELX604_QP1

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Note to the students:- All the Questions are compulsory and carry equal marks .

Q1.	Signals which can be defined by mathematical expressions are called as:
Option A:	Random Signals
Option B:	Deterministic Signals
Option C:	Causal Signals
Option D:	Static Signals
Q2.	_____ is a physical quantity which varies with any independent variable
Option A:	System
Option B:	Current
Option C:	Signal
Option D:	Weight
Q3.	Main step to convert continuous time signal to discrete time is:
Option A:	Sampling
Option B:	Modulating
Option C:	Integrating
Option D:	Differentiation
Q4.	Let $x_1(t)$ and $x_2(t)$ be periodic signals with fundamental periods T_1 and T_2 respectively. Which of the following must be a rational number for $x(t)=x_1(t)+x_2(t)$ to be periodic?
Option A:	$T_1 + T_2$
Option B:	$T_1 - T_2$
Option C:	T_1 / T_2
Option D:	$T_1 * T_2$
Q5.	If a signal $x(t)$ is processed through a system to obtain the signal $x(t^2)$, then the system is said to be _____
Option A:	Linear
Option B:	Non Linear

Option C:	Exponential
Option D:	Static
Q6.	Which of the following is an energy signal?
Option A:	$x(t) = Ae^{j\Omega t}$
Option B:	$x(t) = A\sin\Omega t$
Option C:	$x(t) = B\cos\Omega t$
Option D:	$x(t) = Ae^{-a t} u(t)$
Q7.	If $h_1(n)$ and $h_2(n)$ are impulse responses of two stable LTI systems connected in cascade, then it's overall impulse response is
Option A:	$h_1(n) * h_2(n)$
Option B:	$h_1(n) + h_2(n)$
Option C:	$h_1(n) - h_2(n)$
Option D:	$h_1(n) \cdot h_2(n)$
Q8.	The type of systems which are characterized by input and the output capable of taking any value in a particular set of values are called as:
Option A:	Analog
Option B:	Discrete
Option C:	Continuous
Option D:	Digital
Q9.	The system characterized by equation $y(t) = ax(t) + b$ is
Option A:	Linear for any value of b
Option B:	Linear if $b > 0$
Option C:	Linear if $b < 0$
Option D:	Non linear
Q10.	Convolution of the two discrete time sequences $x_1(n) = \{1, 2, 3, 4\}$ and $x_2 = \{1, -1, 0, 1\}$
Option A:	$\{1, 1, 1, 1\}$
Option B:	$\{1, 1, 1, 2, -2, 3, 4\}$
Option C:	$\{4, 3, 1, 1, 1, 2, -2\}$
Option D:	$\{1, 1, 1, -2, 2, 3, 4\}$
Q11.	Laplace Transform of the signal $x(t) = u(t)$ is:
Option A:	$1/s$
Option B:	$1/s^2$
Option C:	s
Option D:	1
Q12.	The ROC of causal signal $x(t)$ is
Option A:	Entire S -plane
Option B:	RHS of S- plane
Option C:	LHS of S- plane

Option D:	RHS of S- plane except at $s = 0$
Q13.	The Laplace transform of $x(t)=u(t-2)$
Option A:	$e^{-2s} \frac{1}{s+2}$
Option B:	$e^{-s} \frac{2}{s}$
Option C:	$e^{-s} \frac{1}{s+2}$
Option D:	$e^{-2s} \frac{1}{s}$
Q14.	Laplace transform of $A \sin wt u(t)$
Option A:	$\frac{Aw}{s^2+w^2}$
Option B:	$\frac{w}{s^2+w^2}$
Option C:	$\frac{As}{s^2+w^2}$
Option D:	$\frac{1}{s^2+w^2}$
Q15.	The Z –Transform $X(z) = 3+2z^{-1}+5z^{-2}+7z^{-3}$ is for the following signal
Option A:	{3, 2, 5, 7} centre at 2
Option B:	{3, 2, 5, 7} centre at 3
Option C:	{3, 2, 5, 7} centre at 5
Option D:	{3, 2, 5, 7} centre at 7
Q16.	Z transform of $3^n u(n-10)$
Option A:	$Z^{-10} \frac{z}{z-3}$
Option B:	$Z^{10} \frac{z}{z-3}$
Option C:	$Z^{-3} \frac{z}{z-10}$
Option D:	$Z^3 \frac{z}{z-10}$
Q17.	$Z\{a_1x_1(n)+a_2x_2(n)\} = a_1X_1(z) + a_2X_2(z)$ is the
Option A:	Causality Property
Option B:	Linearity Property
Option C:	Non Linearity Property
Option D:	Time Invariant Property
Q18.	Z transform of $2^n u(n-2)$
Option A:	$2(Z-2)$
Option B:	$\frac{4}{Z^2-2Z}$
Option C:	$\frac{Z}{Z^2-2Z}$
Option D:	$\frac{4}{Z^2-4Z}$
Q19.	The z-transform of $(n-k)$ is
Option A:	z^{-n}

Option B:	z^{-k}
Option C:	$\frac{1}{z-n}$
Option D:	$\frac{1}{z-k}$
Q20.	The Fourier transform of the signal $e^{-4 t }$ is _____
Option A:	$8/(16 + \omega)^2$
Option B:	$-8/(16 + \omega)^2$
Option C:	$4/(16 + \omega)^2$
Option D:	$-4/(16 + \omega)^2$
Q21.	By convolution property of Fourier transform , $F\{x(t) * h(t)\}$ is
Option A:	$\frac{1}{2\pi} \int_{-\infty}^{\infty} X(j\Omega) H(j\Omega) d\Omega$
Option B:	$X(j\Omega)H(j\Omega)$
Option C:	$X(j\Omega) - H(j\Omega)$
Option D:	$X(j\Omega) + H(j\Omega)$
Q22.	The Fourier transform of a function $x(t)$ is $X(j\Omega)$. Then, the Fourier transform of $\frac{d}{dx} x(t)$ will be
Option A:	$\frac{dX(\Omega)}{dF}$
Option B:	$j2\pi\Omega X(\Omega)$
Option C:	$j\Omega X(j\Omega)$
Option D:	$\frac{X(\Omega)}{j\Omega}$
Q23.	If the signal $x(t)$ has half wave symmetry, then, the Fourier series will have only,
Option A:	Odd harmonics of sine terms.
Option B:	Constant term and odd harmonics of cosine terms.
Option C:	Even harmonics of sine terms.
Option D:	Odd harmonics of cosine terms
Q24.	The Fourier coefficient ' a_n ' can be calculated as
Option A:	$a_n = \frac{2}{T} \int_{-\infty}^{\infty} x(t) \cos n \Omega_0 t dt$
Option B:	$a_n = \frac{2}{T} \int_0^T x(t) \cos n \Omega_0 t dt$
Option C:	$a_n = \frac{2}{T} \int_{-T/2}^{T/2} x(t) \sin n \Omega_0 t dt$
Option D:	$a_n = \frac{2}{T} \int_0^{\infty} x(t) \cos n \Omega_0 t dt$
Q25.	DTFT is periodic with period
Option A:	π
Option B:	2π
Option C:	$\pi/2$
Option D:	$\pi/4$

